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# THE SOLAR ARRAY SYNTHESIS COMPUTER PROGRAM

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THE SOLAR ARRAY SYNTHESIS COMPUTER PROGRAM

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#### ABSTRACT

Solar-cell arrays provide the primary energy source for most earth-orbiting satellites. The solar cell utilizes the radiative energy from the sun in direct photovoltaic conversion to provide electrical power to the spacecraft. The computer program described here will account for all factors - including isolation diode voltage losses, charged particle irradiation, temperature, solar incidence angle and other solar cell degradation factors - affecting the power output of solar arrays, and thereby greatly reduce the lengthy and laborious hand calculations now necessary in designing an array or predicting its performance.

The program will determine the total power output of solar arrays consisting of up to 25 electrically-parallel panels; each panel may have its own series-parallel solar cell arrangement, temperature verses time profile and sun angle verses time profile. The output of the program is a series of current-voltage (I-V) points representing the total solar array I-V characteristic at up to 20 times during an orbit.

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## THE SOLAR ARRAY SYNTHESIS COMPUTER PROGRAM

### I. INTRODUCTION

The accurate determination of a solar array's power output in orbit is essential in the adequate design of a spacecraft power system. The lengthy and laborious hand calculations now associated with this determination can be greatly reduced through the use of the Solar Array Synthesis Computer Program. This program will compute and print out solar array output I-V (current-voltage) characteristics for arrays consisting of up to twenty-five (25) solar cell panels. Each panel may have its own series - parallel solar cell arrangement, temperature verses time and solar incidence angle verses time profiles. Also, the program will account for isolation diode voltage losses, charged particle irradiation degradation and other solar cell degradation factors. Calculations may be performed for cells of either 1 or 10 ohm-cm nominal base resistivity.

An individual solar cell I-V characteristic is entered into the computer data deck as a series of current and voltage points at nominal solar intensity and room temperature. After calculating the equivalent 1-Mev electron flux from the given charged particle spectrum, the program will degrade the solar cell characteristic to account for the equivalent 1-Mev flux. The cell I-V curve is next shifted to account for user-specified current and voltage degradation factors. The fully-degraded solar cell I-V characteristic is then extrapolated into a family of solar cell I-V curves at nominal intensity for 15 temperatures (covering the temperature range of interest to the user) through the use of specified current and voltage temperature coefficients and appropriate changes to the I-V curve shape. Each panel's contribution to the total solar array I-V curve is determined separately depending upon the panel's solar cell arrangement, temperature and sun angle; all solar cells on any one panel must be operating at the same temperature and solar incidence angle.

Summing the individual panel output currents at a voltage as voltage is increased from zero to the open-circuit value of the highest-voltage panel, in one-volt increments, yields the total solar array I-V characteristics. Up to 20 such solar array I-V curves can be obtained during a single program execution, corresponding to 20 equal time increments during an orbit, or 20 combinations of solar panel temperature and illumination incidence angle as defined by the program user in the input data.

The program consists of five parts:

- MAIN - reads input data, prints output data, calls the subroutines as required, computes and stores individual panel I-V curves for up to

twenty-five panels and computes the total resulting solar array I-V curve in one volt increments.

- PHI - computes a damage - equivalent, normally - incident (deni) 1-Mev electron flux from tables of omnidirectional electron, proton, solar flare proton and solar flare alpha particle fluxes, accounting for the protection afforded by the selected values of coverglass and back-shielding thicknesses.
- DEGRAD - degrades a room temperature solar cell I-V curve for the equivalent 1-Mev electron flux computed by Subroutine PHI or any other user-specified value of equivalent 1-Mev electron flux.
- STASH - degrades a solar cell I-V curve for current and voltage degradation factors and series resistance effects and computes and stores the degraded cell I-V curve over the specified temperature range.
- STINT - stores in tables, and then supplies on command, the values of variables which are functions of one, two or three arguments. The name stands for Standard Table Interpolation, and is an adaption of the STINT routine which is a part of the IBM SHARE library.

The program user may elect to perform solar cell calculations only, or solar cell and solar array calculations. Any number of runs may be chained together if desired. The program, originally written in the FORTRAN II computer language compatible with the IBM 7094 computer, has been converted to the FORTRAN IV language for use on the IBM 360 computer. The information contained in this report pertains equally to both versions.

## II. PROGRAM DESCRIPTION

This section provides a description of each of the program subroutines. Figure 1 presents a basic block diagram of the solar array synthesis program and summarizes the important functions of each subroutine.

### A. MAIN - Computer Program Control

The primary function of the MAIN routine is to perform all data input and parameter initialization, and call the other subroutines as required. In addition, MAIN performs all of the solar array calculations. Up to 20 solar array I-V curves can be determined during one computer run, corresponding to 20 equal time increments during the sunlight-illuminated portion of an orbit or any 20 specified combinations of solar panel sun angle and temperature.



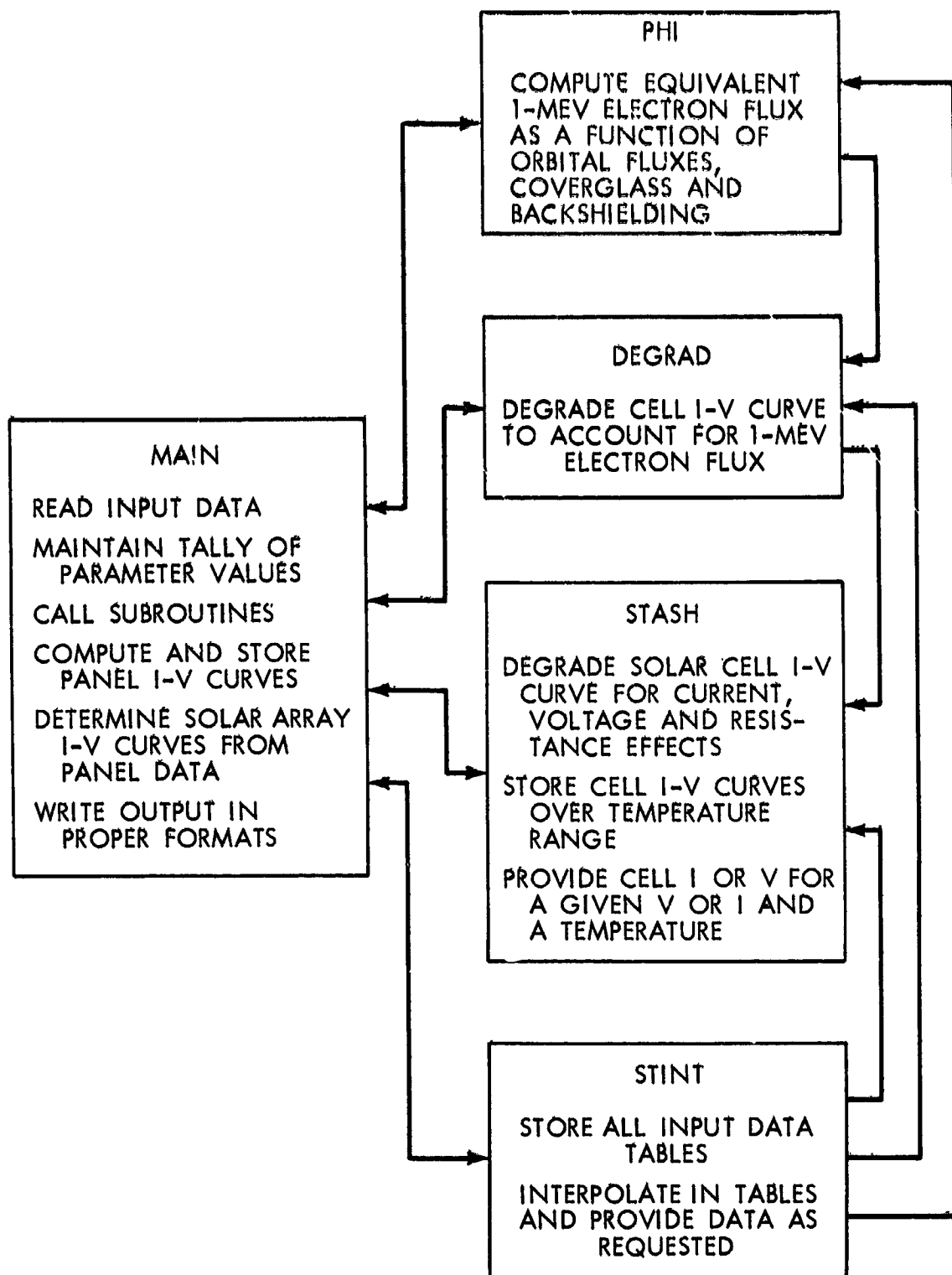


Figure 1. Subroutine Functions in Solar Array Synthesis Computer Program

The contribution to the total solar array I-V curve of each of up to 25 parallel panels is calculated individually. After first determining the panel's operating temperature and solar incidence angle, a representative solar cell curve is constructed. A total panel I-V curve is determined by multiplying the representative cell's current values by the number of parallel strings on the panel, and the voltage points by the panel's number of series solar cells. (Each parallel string of a given panel must have the same number of series cells, although separate panels may have different series - parallel combinations.) If the program user has specified a value of array blocking diode loss, this drop is incorporated into the calculation of the panel I-V curve. Summation of the individual panel curves yields a total solar array I-V characteristic at each time increment.

### B. Subroutine PHI - Calculation of 1-Mev Electron Flux

Subroutine PHI converts the known charged particle spectrum of the four types of particles which damage solar cells most: trapped orbital electrons, trapped orbital protons, solar-flare protons and solar-flare alpha particles, to a damage-equivalent, normally-incident (deni) 1-Mev electron flux. Solar cell irradiation degradation is usually defined in terms of this low-energy flux because the damage equivalency of 1-Mev electrons for each type and energy range of space particle has been defined.<sup>1</sup> Once calculated, the 1-Mev equivalent flux for each type of particle is summed to determine the total 1-Mev flux the cell experiences.

A flux table, prepared for each type of particle, contains the particle's flux population through specific energy ranges for a particular time in orbit. Tables 1 through 4 list the energy ranges for each type of particle and gives the population of each at one year in a given example orbit. The electron environment is broken into 11 ranges; the other particle environments are divided into 18 ranges. The program will operate properly only when the particle populations are divided into the energy ranges specified in tables 1 through 4.

The program calculates the equivalent 1-Mev electron flux for each type of particle by applying a damage factor (KD) to the population of each energy range; damage factors depend on the effective coverglass and backshielding densities (gm/cm<sup>2</sup>) protecting the solar cell. Tables 5 and 6 list damage factors for orbital electrons and protons, based on the data reported by Brown, Gabbe and Rosenzweig.<sup>2</sup> Although previously trapped orbital protons were distinguished from solar-flare protons-based primarily on the relative uncertainty associated with the solar-flare proton model-both proton classifications will use the same damage factor table. Damage factors for alpha particles, from the work of Smith and Blue,<sup>3</sup> are based on the relationship:

$$3.8 \varphi_p(E) = \varphi_A(4E)$$

Table 1  
Electron Flux Format

Energy Range Number	$\Delta E$ (Mev)	Ne (Electrons/cm <sup>2</sup> )
1	0.0-0.25	1.06E15
2	0.25-0.50	8.58E14
3	0.50-0.75	2.84E14
4	0.75-1.0	9.12E13
5	1.0-2.0	3.87E12
6	2.0-3.0	1.49E11
7	3.0-4.0	1.42E9
8	4.0-5.0	1.08E7
9	5.0-6.0	1.13E5
10	6.0-7.0	6.57E4
11	> 7.0	3.65E3

Table 2  
Proton Flux Format

Energy Range Number	$\Delta E$ (Mev)	Np (Protons/cm <sup>2</sup> )
1	0.0-1.0	8.47E13
2	1.0-2.0	1.23E11
3	2.0-3.0	1.50E10
4	3.0-4.0	7.99E9
5	4.0-5.0	4.49E9
6	5.0-6.0	2.50E9
7	6.0-7.0	2.00E9
8	7.0-8.0	1.10E9
9	8.0-9.0	4.35E8
10	9.0-10.0	4.49E8
11	10.0-11.0	3.98E8

Table 2 (Continued)

Energy Range Number	$\Delta E$ (Mev)	Np (Protons/cm <sup>2</sup> )
12	11.0-12.0	3.98E8
13	12.0-13.0	3.98E8
14	13.0-14.0	1.50E8
15	14.0-15.0	1.14E8
16	15.0-30.0	8.98E8
17	30.0-100.0	8.47E8
18	>100.0	1.40E8

Table 3  
Solar-Flare Proton Flux Format

Energy Range Number	$\Delta E$ (Mev)	Nfp (Protons/cm <sup>2</sup> )
1	0.0-1.0	0.0
2	1.0-2.0	6.06E10
3	2.0-3.0	1.50E10
4	3.0-4.0	7.99E9
5	4.0-5.0	4.49E9
6	5.0-6.0	2.48E9
7	6.0-7.0	1.97E9
8	7.0-8.0	1.09E9
9	8.0-9.0	6.97E8
10	9.0-10.0	4.49E8
11	10.0-11.0	3.98E8
12	11.0-12.0	3.98E8
13	12.0-13.0	3.98E8
14	13.0-14.0	2.99E8
15	14.0-15.0	2.48E8

Table 3 (Continued)

Energy Range Number	$\Delta E$ (Mev)	Nfp (Protons/cm <sup>2</sup> )
16	15.0-30.0	1.79E9
17	30.0-100.0	1.68E9
18	> 100.0	1.97E9

Table 4  
Solar-Flare Alpha Particle Flux Format

Energy Range Number	$\Delta E$ (Mev)	Nfa (Alpha-Particles/cm <sup>2</sup> )
1	16-18	3.98E7
2	18-20	2.99E7
3	20-22	2.99E7
4	22-25	2.99E7
5	25-30	3.98E7
6	30-32	1.97E7
7	32-35	1.97E7
8	35-40	1.97E7
9	40-45	1.97E7
10	45-47	9.86E6
11	47-52	1.17E7
12	52-57	1.28E7
13	57-60	4.96E6
14	60-80	3.20E8
15	80-100	1.97E7
16	100-200	2.23E7
17	200-400	4.49E5
18	> 400	9.86E5

Table 5  
Damage Factors for Electrons (KDE)

Energy Range Number	Shielding Number						
	0.0	1.0	1.5	3.0	6.0	9.0	200.0
1	0.01	0.0	0.0	0.0	0.0	0.0	0.0
2	0.06	0.03	0.02	0.0	0.0	0.0	0.0
3	0.18	0.13	0.08	0.03	0.0	0.0	0.0
4	0.38	0.30	0.20	0.10	0.02	0.0	0.0
5	1.3	1.15	1.02	0.75	0.47	0.25	0.0
6	2.9	2.70	2.50	2.05	1.55	1.10	0.0
7	4.35	4.15	3.92	3.38	2.85	2.15	0.0
8	5.5	5.30	5.15	4.60	4.10	3.30	0.0
9	6.5	6.15	6.10	5.70	5.30	4.60	0.0
10	7.4	7.30	7.30	6.80	6.50	5.85	0.0
11	7.8	7.80	7.80	7.70	7.50	7.0	0.0

Table 6  
Damage Factors for Protons (KDP)

Energy Range Number	Shielding Number						
	0.5	1.0	1.5	3.0	6.0	9.0	200.0
1	0.0	0.0	0.0	0.0	0.0	0.0	0.0
2	0.0	0.0	0.0	0.0	0.0	0.0	0.0
3	6000.0	0.0	0.0	0.0	0.0	0.0	0.0

Table 6 (Continued)

Energy Range Number	Shielding Number						
	0.5	1.0	1.5	3.0	6.0	9.0	200.0
4	5400.0	0.0	0.0	0.0	0.0	0.0	0.0
5	4500.0	3000.0	0.0	0.0	0.0	0.0	0.0
6	3900.0	3700.0	2000.0	0.0	0.0	0.0	0.0
7	3500.0	3500.0	3100.0	0.0	0.0	0.0	0.0
8	3100.0	3100.0	3100.0	200.0	0.0	0.0	0.0
9	2800.0	2800.0	2800.0	1400.0	0.0	0.0	0.0
10	2700.0	2700.0	2700.0	2000.0	0.0	0.0	0.0
11	2600.0	2600.0	2600.0	2100.0	0.0	0.0	0.0
12	2500.0	2500.0	2500.0	2100.0	100.0	0.0	0.0
13	2500.0	2500.0	2500.0	2100.0	1000.0	0.0	0.0
14	2500.0	2500.0	2500.0	2000.0	1400.0		0.0
15	2500.0	2500.0	2500.0	2000.0	1500.0	100.0	0.0
16	2500.0	2500.0	2500.0	2000.0	1800.0	1500.0	0.0
17	2300.0	2300.0	2300.0	2000.0	2000.0	2000.0	0.0
18	1000.0	1000.0	1000.0	1000.0	1000.0	1000.0	0.0

This relationship states that an alpha particle of four times the energy of a proton does 3.8 times the damage of the proton. Table 7 lists damage factors for alpha particles. The program user must specify an equivalent thickness of back-shielding and coverglass for each computation; Table 8 lists the stored shielding densities, and equivalent thicknesses of fused silica coverglass and aluminum

Table 7  
Damage Factors for Alpha Particles (KDA)

Energy Range Number	Shielding Number						
	0.0	1.0	1.5	3.0	6.0	9.0	200.0
1	20000.0	10000.0	0.0	0.0	0.0	0.0	0.0
2	15000.0	13000.0	0.0	0.0	0.0	0.0	0.0
3	14500.0	14000.0	7000.0	0.0	0.0	0.0	0.0
4	13700.0	13700.0	11000.0	0.0	0.0	0.0	0.0
5	12500.0	12500.0	12000.0	0.0	0.0	0.0	0.0
6	11500.0	11500.0	11500.0	2500.0	0.0	0.0	0.0
7	11000.0	11000.0	11000.0	5200.0	0.0	0.0	0.0
8	10400.0	10400.0	10400.0	7200.0	0.0	0.0	0.0
9	9800.0	9800.0	9800.0	7900.0	0.0	0.0	0.0
10	9500.0	9500.0	9500.0	8000.0	1700.0	0.0	0.0
11	9500.0	9500.0	9500.0	7800.0	3650.0	0.0	0.0
12	9500.0	9500.0	9500.0	7700.0	5200.0	0.0	0.0
13	9500.0	9500.0	9500.0	7600.0	5700.0	1600.0	0.0
14	9400.0	9400.0	9400.0	7600.0	6300.0	4000.0	0.0
15	9200.0	9200.0	9200.0	7600.0	7000.0	6400.0	0.0
16	8600.0	8600.0	8600.0	7700.0	7400.0	7100.0	0.0
17	7000.0	7000.0	7000.0	7000.0	7000.0	7000.0	0.0
18	4000.0	4000.0	4000.0	4000.0	4000.0	4000.0	0.0



Table 8  
Shielding Numbers

Shielding Density (gm/cm <sup>2</sup> )	0.016	0.033	0.05	0.1	0.2	0.3	*
Equivalent mils of fused silica coverglass	3.0	6.0	9.0	18.0	36.0	54.0	—
Equivalent mils of Aluminum	2.5	5.0	7.5	15.0	30.0	45.0	1000.0*
Shielding Number for Computer Lookup	0.5	1.0	1.5	3.0	6.0	9.0	200.0

\*Simulates infinite backshielding

backshielding. The user may specify any desired thickness of coverglass or backshielding within the range of stored data. The program will automatically make a linear interpolation between the damager factor values associated with the two closest thicknesses to determine the damage factor to be used.

Once the charged particle population of each type of particle has been entered into the computer, and the coverglass and backshielding thicknesses have been selected, the computer can calculate the total equivalent 1-Mev electron flux using the relationship:

$$\varphi_T = \varphi_e + \varphi_p + \varphi_{fp} + \varphi_{fa} \quad (\text{reference 1})$$

where

- $\varphi_T$  = total 1-Mev equivalent flux
- $\varphi_e$  = electron 1-Mev equivalent flux
- $\varphi_p$  = proton 1-Mev equivalent flux
- $\varphi_{fp}$  = solar-flare proton 1-Mev equivalent flux
- $\varphi_{fa}$  = solar-flare alpha particle 1-Mev equivalent flux

The contribution of each particle to the total flux is calculated separately by a summation process. For example,  $\varphi_p$  is calculated by multiplying the population of each of the 18 proton energy ranges by the appropriate damage factors for backshielding and coverglass, then summing each of these products. The

following expression demonstrates this summation process:

$$\varphi_p = \sum_{\Delta E=1}^{18} [KDP \times NP|_{CG} + KDP \times NP|_{BS}]$$

where

KDP = proton damage factor for a given energy range

NP = number of protons in a particular energy range

The equivalent flux for each of the other types of particles is calculated similarly. The value of  $\varphi_T$  is stored by the computer until called for by subroutine DEGRAD.

#### C. Subroutine DEGRAD - Calculation of Solar Cell I-V Curve Irradiation Degradation

Subroutine DEGRAD degrades a single solar cell I-V characteristic to compensate for damage caused by an equivalent 1-Mev flux. The input to this subroutine is either the output of PHI or a user specified 1-Mev flux; in the latter case subroutine PHI is not called and the computer immediately enters subroutine DEGRAD to degrade the I-V curve for the given flux.

The undegraded solar cell I-V curve is entered into the computer as a series of voltage and current points at room temperature and nominal solar intensity ( $140 \text{ mw/cm}^2$ ). The computer interpolates the original points to arrive at 100 current and voltage pairs ( $V_i$  and  $I_i$ ) at 10-mv increments. These interpolated points will then be shifted to account for the charged-particle irradiation degradation.

The effect of a charged particle flux on the solar cell is a decrease in solar cell output current and voltage and a change in the I-V curve shape. Flight and laboratory experiments have shown that a solar cell will incur a "softening" of the I-V curve due to junction damage if low energy protons are allowed to reach the silicon where the coverglass does not completely protect the exposed cell surface. However, the computer program assumes an adequate shielding design and therefore accounts for the effect of bulk damage only (decrease of minority carrier lifetime in the base material). The I-V curve shape change due to the bulk damage is a "squaring" of the curve shape. This change is implemented by a series resistance correction technique in the computer program. A very lucid graphical example of the curve shape change can be found in the Cherry and Statler report on U.S. and European solar cells (Reference 4). This reference includes I-V curves for Heliotek, Centralab and Texas Instruments 10-ohm-cm cells and Heliotek 2-ohm-cm cells, at 1-Mev electron flux levels from 0 to  $10^{16} \text{ e/cm}^2$ . When the  $10^{16}$  I-V curve is traced on a transparent paper overlay and

this curve is now translated to the 0 flux curve, the sharper line of the irradiated I-V curve is quite obvious for all of the U.S. cells.

Implementation of this effect in the computer is shown in Figure 2.

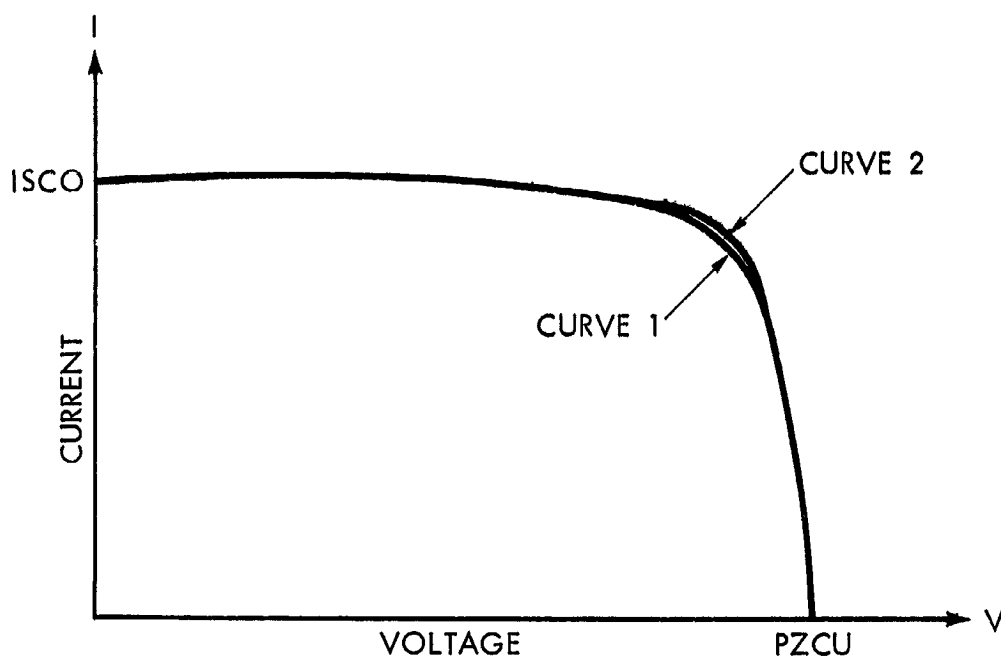


Figure 2. Curve Shape Correction

A curve shape correction, dependent on the equivalent 1-Mev flux, effectively sharpens the knee of the curve by adding a negative "radiation resistance" (RR) correction to each voltage point of the curve:

$$V_{i\text{corrected}} = V_{i\text{initial}} + I_i \times RR \text{ (reference 1)}$$

RR is defined as "volts at short circuit current (VISC) divided by the initial, undegraded value of short circuit current (ISCO)." Values of VISC, dependent upon flux level and solar cell base resistivity, are entered as a portion of the user specified input data (STINT table number 10: "NMVTBL CURVE SHAPE VOLTS VS PHI"). The proper value of VISC will be determined by a linear interpolation between the values associated with the flux levels closest to actual value of  $\phi_T$ . Figure 2 shows the effect of the curve shape correction. Curve 1 is the original I-V curve and curve 2 shows the sharpening of the knee caused by the charged-particle irradiation.

Next the program shifts the total I-V curve parallel to the current axis an amount  $\Delta I$  to account for the reduction in short circuit current caused by the

equivalent flux. The current increment is calculated as  $ISCO(1-RI)$ , where  $RI$  is defined as the relative short-circuit current degradation factor. Equations for  $RI$ , dependent on cell base resistivity and flux level, are contained in the program. Curve 3 of Figure 3 is determined by subtracting  $\Delta I$  from each current point of curve 2:  $I_i = I_i - \Delta I$ . The point PZCD is not the actual degraded open-circuit voltage, but merely a temporary value of the "point of zero current" of the cell.

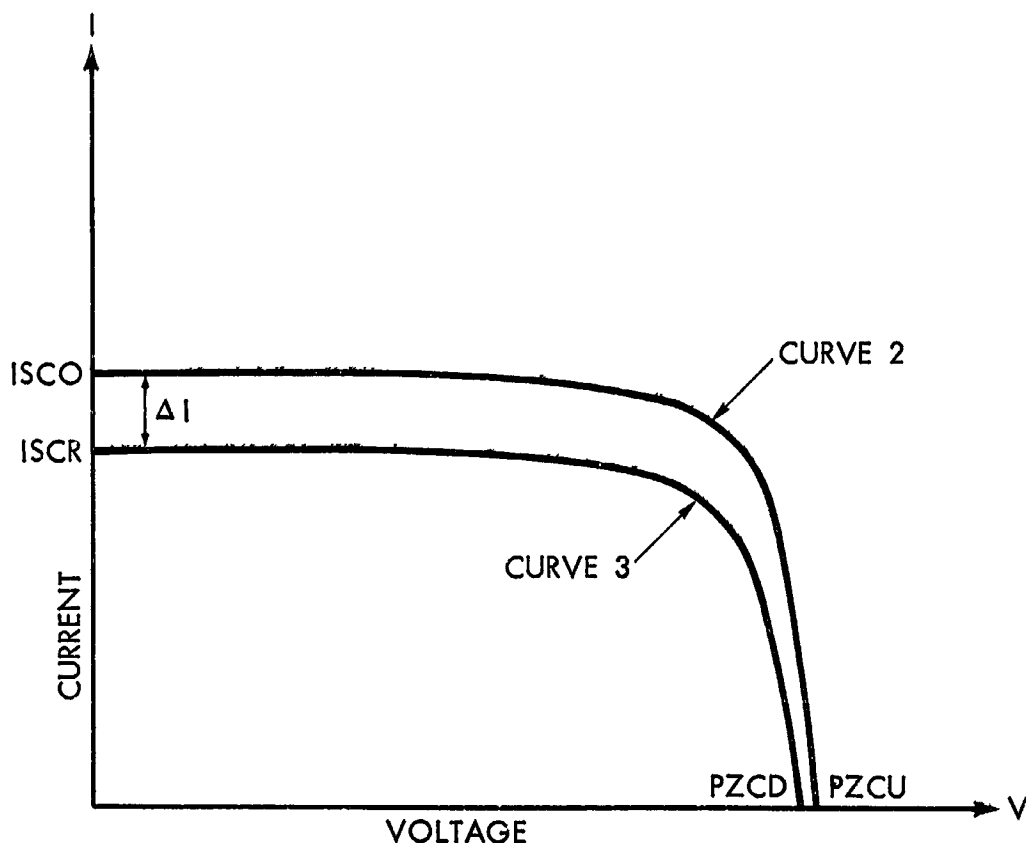


Figure 3. Short Circuit Current Correction

A final characteristic correction is made to account for the reduction of open-circuit voltage in the solar cell caused by the equivalent flux. The relative open-circuit voltage degradation factor,  $RV$ , is calculated through the use of stored equations. (Unlike the previous degradation parameters,  $RV$  depends only on the equivalent flux and not on the solar cell base resistivity.) The degraded open-circuit voltage ( $VOCR$ ) is calculated as  $(PZCU \times RV)$ , where  $PZCU$  is the initial undegraded value of cell open-circuit voltage. The curve is then shifted parallel to the voltage axis an amount  $\Delta V$  - defined as  $(PZCD - VOCR)$  - by subtracting  $\Delta V$  from each voltage point:  $V_i = V_i - \Delta V$ . Curve 4 of Figure 4 shows the fully degraded solar cell I-V curve.

Figure 5 shows typical solar cell I-V curves for various flux levels. A small computer program employing the techniques of PHI and DEGRADE has been developed and is described in Reference 5.

#### D. Subroutine STASH - Solar Cell Degradation and Temperature Effects

The purpose of subroutine STASH is to account for all factors, with the exception of charged particle irradiation degradation, which effect the solar cell's I-V characteristic. External series resistance effect, illumination intensity change, voltage measurement error and temperature effect are all included. The input to this subroutine, curve 1 of Figure 6, is either the output of DEGRAD or, if beginning-of-life calculations are being performed, the program's original input solar cell I-V curve. In the latter case, subroutines PHI and DEGRAD are bypassed and the computer immediately enters subroutine STASH to account for the user-specified current and voltage degradation factors and temperature effects. All design uncertainties, or factors for a conservative design, should be included when the degradation factors and temperature coefficients are selected.

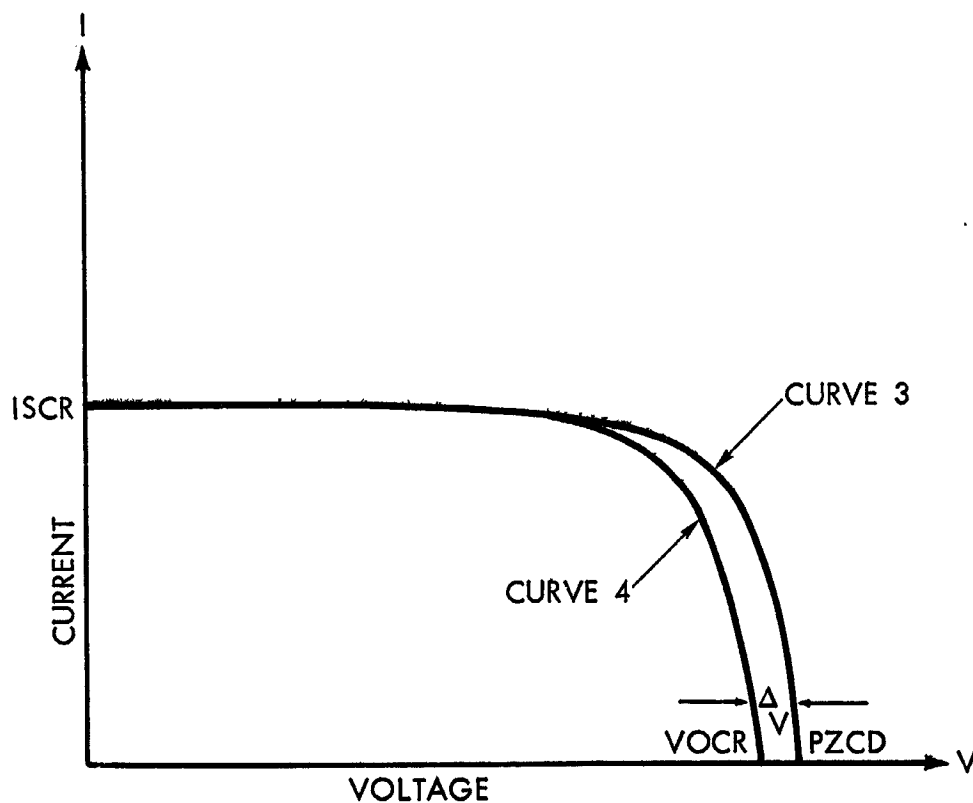


Figure 4. Open Circuit Voltage Correction

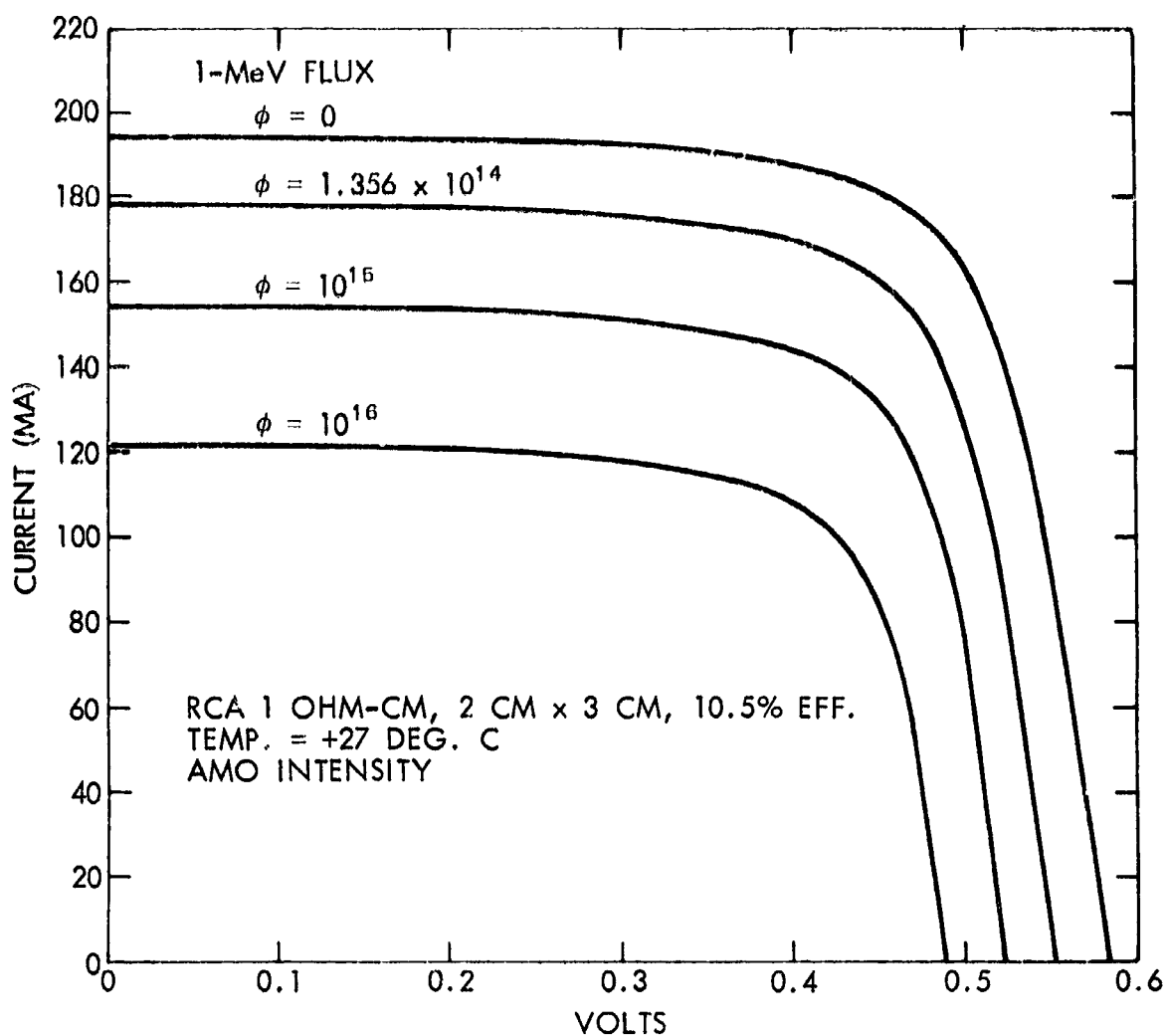


Figure 5. Solar Cell I-V Curves at Various Flux Levels

The I-V characteristic is first shifted parallel to the current axis an amount DELI to account for the current degradation factors DI1 through DI4; each factor is defined as a percentage of short circuit current remaining after degradation. (For example, if it is assumed that DI1 causes a 10% loss in short circuit current, DI1 would have a value of 90.0.) DELI is defined as  $ISC1(1-\gamma)$ , where  $\gamma$  is merely the product of the four current degradation factors. Although the four parameters usually refer to standard cell error, solar intensity variation, ultraviolet degradation and current measurement error, respectively, any four factors which effect the solar cell's short circuit current output may be used. The current-shifted I-V curve is translated parallel to the voltage axis until  $V_2$  is intercepted, which accounts for the change in open-circuit voltage caused by the relative decrease in short circuit current. Curve 2 of Figure 6 shows the current-degraded I-V characteristic.

A voltage degradation factor which effects all voltages on the I-V curve equally is usually defined as a percentage of the open circuit voltage of the reference I-V curve. Such a factor may be a voltage measurement error. The I-V curve is corrected to account for this factor by translating the entire curve parallel to the voltage axis an amount DELV :  $DELV = \frac{\text{percentage degradation}}{100} \times V_1$ .

Curve 3 of Figure 7 shows the voltage degraded I-V curve; VOC is the degraded value of open circuit voltage.

A final correction is made to the cell's I-V characteristic to account for an effective increase in the external series resistance. This increase, which is usually caused by either a series wiring loss or thermal cycling degradation, is defined as a percentage loss of voltage at the maximum power point of the solar cell I-V curve. There is, in addition, a corresponding voltage loss to all other points on the I-V curve which is proportional to the current at each point. Figure 8 shows the I-V characteristic before and after the resistance change;  $V_{pmo}$  is the original maximum power point voltage, while  $V_{pmr}$  is the degraded value.

After applying the degradation factors, subroutine STASH uses the current and voltage temperature coefficients to expand the fully degraded I-V curve into a family of curves at fifteen temperatures. Maximum power, maximum power point voltage and current, open circuit voltage and short circuit current values are calculated at each temperature.

A detailed technical discussion of the techniques employed in this subroutine is contained in Reference 6.

#### E. Subroutine STINT - Data Storage and Retrieval

Subroutine STINT merely stores in tables, and then supplies on demand, the values of variables which are functions of one, two or three arguments. The first use of STINT loads the tabular data into the computer. Subsequent STINT calls will ask for a linear interpolation to be performed which corresponds to the supplied argument values.

As an example, STINT table No. 12 of Appendix B gives a typical solar array temperature verses time profile for a Nimbus orbit. If the program user has requested that a solar array I-V curve be generated at 21 minutes into the sunlight portion of the orbit, MAIN will call STINT to determine the array temperature at this time in orbit. By interpolating between the array temperatures corresponding to the two closest time references - in this case 20.0 and 25.0 minutes - STINT calculates an array temperature of 19.0 degrees; this value is returned to MAIN.

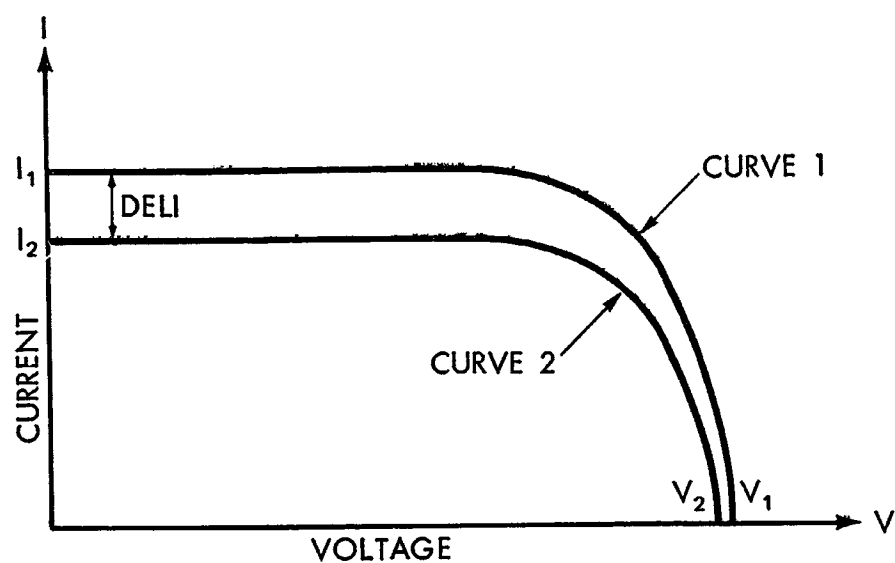


Figure 6. Short Circuit Current Degradation Effects

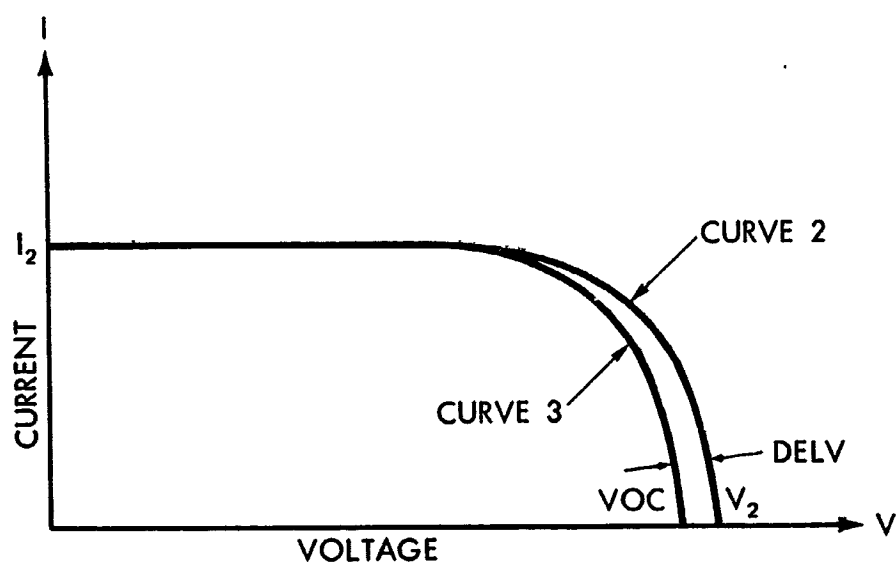


Figure 7. Open Circuit Voltage Degradation Effects



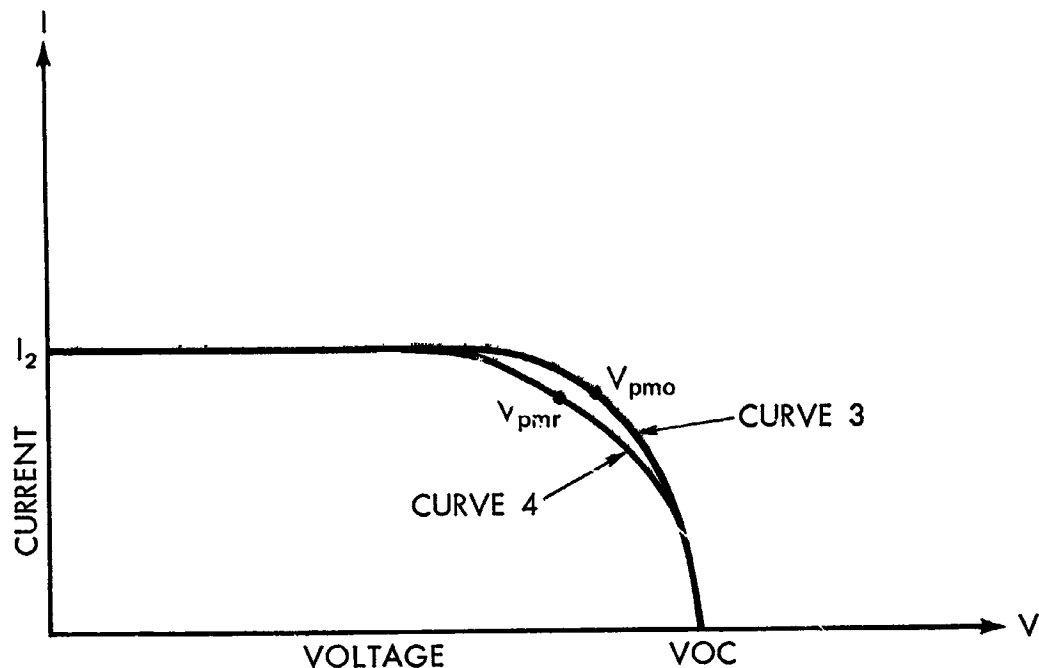


Figure 8. External Series Resistance Correction

One and two argument functions may be stored in single tables - Tables 1 and 7 are examples of one and two argument functions, respectively. Three argument functions must be stored in consecutive two argument tables; the number of two argument tables will be equal to the number of argument<sub>3</sub> values.

Subroutine STINT is called by means of a statement with the following format:

CALL STINT (ARG1, ARG2, ARG3, FCT, KEY, NGRIP, MINTBL, MAXTBL)

The first three dummy variables are the three arguments; zeroes must be substituted for unused arguments. FCT is the variable value to be calculated, and KEY tells the computer what kind of operation is to be performed. A value of -1 indicates the table-loading mode, while a +1 calls for a linear interpolation to be performed. NGRIP is an error flag. MINTBL and MAXTBL are the number of the STINT tables used; both tables are the same if the variable is a function of two arguments. MINTBL is set equal to the table number which contains the lowest value of argument<sub>3</sub> values and MAXTBL is set to the table which contains the highest argument<sub>3</sub> values if the variable is a function of three arguments.

### III. PROGRAM USAGE

The following describes the mechanics of using the program in "non-programmer" language. Appendix A contains a program deck listing, while Appendix B illustrates a typical data deck set-up written in the FORTRAN IV computer language.

The assembly of the complete program as it is submitted to the computer is shown in Figure 9. This assembly basically consists of two parts — a program deck and a data deck. The program deck is always used and is placed first in the assembly. It contains the MAIN routine and all of the subroutines used in the program (STINT, PHI, DEGRAD and STASH) and does not require any card changes to perform its function.

The data deck contains all the numerical information the program requires for computation and defines the user-selected options for each run. Consequently, the data deck must be prepared specifically for each run, or series of chained runs, to be made. Cards and tables in the data deck must be positioned in the order shown in the program assembly in Figure 9. The data deck description and format are presented below in the proper assembly sequence.

Asterisk Data Card. The first card in the data deck is labeled:

Column 1                    \*

Columns 7 - 10            DATA

Date and List Option Card

Column 1-2                Number of month

Column 3-4                Number of day

Column 5-6                Number of year

Column 9                  0 - Input data (STINT) tables not printed out

Column 9                  1 - Input data (STINT) tables printed out in  
                             exponential format

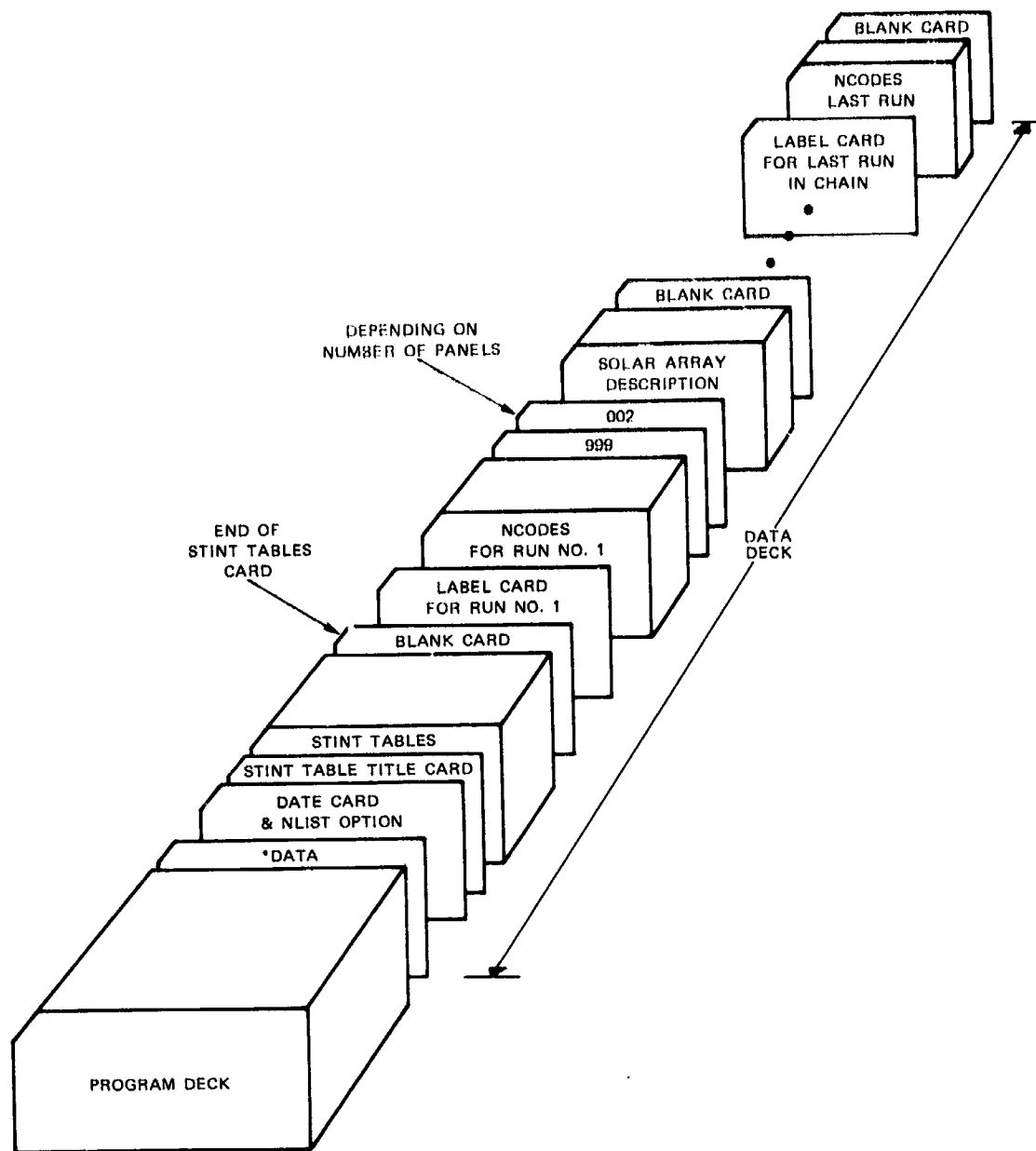


Figure 9. Program Assembly

STINT Table Title Card

Column 1          Blank

Column 2-72      Any Alpha-Numeric information

The STINT tables are stacked one behind the other in the data deck in ascending numerical order. The ten tables listed below must always be present in the data deck, in the order shown.

<u>Table #</u>	<u>Table Name</u>
1	Solar Cell I-V Curve
2	Relative Solar Array Current vs. Incidence Angle
3	Orbital Electrons 1 yr. 600 N.M. (or suitable substitute)
4	Orbital Protons 1 yr. 600 N.M. (or suitable substitute)
5	Solar Flare Protons 1 yr. 600 N.M. (or suitable substitute)
6	Solar Flare Alpha Particles 1 yr. 600 N.M. (or suitable substitute)
7	Damage Factors for Electrons
8	Damage Factors for Protons
9	Damage Factors for Alpha Particles
10	NMVTBL Curve Shape Volts vs. PHI

The maximum number of STINT tables that the program will accept is 60; the 10 above tables plus, starting with Table No. 11, a sun angle vs. time table and a temperature vs. time table for each of the 25 panels comprising the solar array. If fewer than the maximum number (25) of panels is specified, fewer STINT tables are required. More than one panel may use the same angle or temperature table stored in STINT.

The first card of each STINT table is a header card, which must be prepared in the following format:

Columns 1-8	:	Any alpha-numeric characters can be used for a date.
Columns 9-12	:	Table number. Cannot be zero. Fixed point and right-justified.
Columns 13-14	:	Number of argument <sub>1</sub> values. Cannot be zero. Fixed point and right-justified.
Columns 15-16	:	Number of argument <sub>2</sub> values. Cannot be zero, is 1 for a function of one argument. Fixed point and right-justified.
Columns 17-19	:	Not used.

Columns 20-70 : Any alpha-numeric characters desired. Usually used for table title.

Columns 71-72 : 00

After the header card, each card in the table uses 10 fields of 7 columns each for the argument values and the function values. The first card contains the first nine argument<sub>1</sub> values in fields 2 through 10. In the following cards, field 1 contains an argument<sub>2</sub> value, and fields 2 through 10 contain corresponding function values. After all the argument<sub>2</sub> values have been spanned, the whole series of an argument<sub>1</sub> card followed by argument<sub>2</sub> cards can repeat until all the function values are used. If there is an argument<sub>3</sub> value for the table, it goes into field 1 of the argument<sub>1</sub> card. Columns 71 and 72 on each card must contain a sequence number, starting with 01 for the first card. Figure 10 shows a typical STINT table coding sheet for a single argument (current as a function of voltage) STINT table. Figure 11 shows a two-argument STINT table format.

After the last STINT table in the data deck, there is a card labeled END OF STINT TABLES, starting in Col. 21. Cols. 9-12 and 71-72 must be left blank on this card. This card is referred to as the blank card following the STINT tables in Figure 9.

#### Run Label Card

Following the END OF STINT TABLES card is a card containing any desired alpha-numeric information in columns 2-72, which usually describes the first run to be made.

#### NCODE

Following the Run Label Card are the 24 NCODE cards. The card number, or NCODE, is right justified against Col. 3. The numerical value of the NCODE variable is left-justified against Col. 5 and must have a decimal point. Figure 10 shows the NCODE names, the NCODE numbers, the NCODE values and a brief description of each NCODE for a sample computer run. Only the NCODE number and its numerical value are punched on the NCODE cards; the other data in Figure 12 are for information only. All 24 of the NCODES are initially loaded into memory, thus a single run or the first of a series of chained runs must contain all the NCODES in the data deck. The NCODE descriptions in Figure 12 are described below:

- a. TD is the total orbit suntime in minutes.
- b. DELTAT is the time increment in the orbit between solar array calculations, starting with 0 minutes (beginning of orbit suntime), and

# FORTRAN TABLES FORMAT

PUNCH 1 CARD AS FOLLOWS

COLS 1-8 0.4 - 0.6 - 6.8 (TBL DATE) COLS 9-12 0.0 0.1 (TBL NO) COLS 13-14 2.7 (ARG 1st) COLS 15-16 0.1 (ARG 2nd) COLS 17-20 (TITLE) COLS 21-72 0.0 (SEQ. NO)

FIELD 1	FIELD 2	FIELD 3	FIELD 4	FIELD 5	FIELD 6	FIELD 7	FIELD 8	FIELD 9	FIELD 10	PRO- GRAM DECK NO.
INTEGER EXP	INTEGER EXP	INTEGER EXP	INTEGER EXP	INTEGER EXP	INTEGER EXP	INTEGER EXP	INTEGER EXP	INTEGER EXP	INTEGER EXP	NO.
1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 17 18 19 20 21	22 23 24 25 26 27 28 29 30 31 32 33 34 35 36 37 38 39 40 41 42 43 44 45 46 47 48 49 50 51 52 53 54 55 56 57 58 59 60 61 62 63 64 65 66 67 68 69 70 71 72 73 74 75 76 77 78 79 80									
0.0	0.225	0.275	0.295	0.315	0.335	0.350	0.365	0.380	0.395	0.1
0.1257	0.1245	0.1241	0.1240	0.1237	0.1231	0.1229	0.1222	0.1213	0.1202	0.2
0.390	0.400	0.410	0.420	0.430	0.440	0.450	0.460	0.470	0.480	0.3
0.1204	0.1194	0.1180	0.1167	0.1149	0.1129	0.1101	0.1066	0.1025	0.0980	0.4
0.480	0.490	0.500	0.510	0.520	0.530	0.540	0.550	0.560	0.570	0.5
0.0974	0.0917	0.0850	0.0765	0.0655	0.0530	0.0400	0.0260	0.0110	0.0000	0.6

Figure 10. Sample Coding Sheet Showing Format for a Single Argument STINT TABLE

# FORTRAN TABLES FORMAT

PUNCH 1 CARD AS FOLLOWS

COLS 1-8 0.4-0.6-6.8 (TBL DATE) COLS 9-12 0.0-0.7 (TBL NO) COLS 13-14 1.1 (ARG 1-2) COLS 15-16 0.6 (ARG 3-4) COLS 17-20 (TITLE) COLS 21-72 0.0 (SEC NO)

FIELD 1 ± INTEGER ± EXP	FIELD 2 ± INTEGER ± EXP	FIELD 3 ± INTEGER ± EXP	FIELD 4 ± INTEGER ± EXP	FIELD 5 ± INTEGER ± EXP	FIELD 6 ± INTEGER ± EXP	FIELD 7 ± INTEGER ± EXP	FIELD 8 ± INTEGER ± EXP	FIELD 9 ± INTEGER ± EXP	FIELD 10 ± INTEGER ± EXP	SEC NO
1 2 3 4 5 6 7 8 9 10 11 12 13 14	15 16 17 18 19 20 21	22 23 24 25 26 27 28	29 30 31 32 33 34 35	36 37 38 39 40 41	42 43 44 45 46 47	48 49 50 51 52 53 54	55 56 57 58 59 60	61 62 63 64 65 66 67	68 69 70 71 72	73 74 75 76
1.0	2.0	3.0	4.0	5.0	6.0	7.0	8.0	9.0	0.1	
1.0	0.0	0.03	0.13	1.15	2.7	4.15	5.3	6.15	0.2	
1.5	0.0	0.02	0.08	1.02	2.5	3.92	5.15	6.1	0.3	
3.0	0.0	0.0	0.03	0.10	2.05	3.38	4.6	5.7	0.4	
6.0	0.0	0.0	0.0	0.02	1.55	2.85	4.1	5.3	0.5	
9.0	0.0	0.0	0.0	0.25	1.1	2.15	3.3	4.6	0.6	
200.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.7	
1.0	7.3	7.8							0.8	
1.5	7.3	7.8							0.9	
3.0	6.8	7.7							1.0	
6.0	6.5	7.5							1.1	
9.0	5.85	7.0							1.2	
200.0	0.0	0.0							1.3	
									1.4	

Figure 11. Sample Coding Sheet Showing Format for a Two-Argument STINT TABLE

NCODE NAME	NCODE NO.	TYPICAL VALUE	RUN COMMENTS OR VARIABLE DESCRIPTION
TD	1	85.0	ORBIT SUNTIME DURATION (MINUTES)
DELTA T	2	5.0	TIME BETWEEN CALCULATIONS (MINUTES)
SIGISC	3	0.00014	ISC TEMP. COEF. (AMPS/DEG.C)
SIGVOC	4	0.0024	VOC TEMP. COEF. (VOLTS/DEG.C)
DI1	5	90.0	ISC DEGRADATION FACTOR (PERCENT)
DI2	6	100.0	ISC DEGRADATION FACTOR (PERCENT)
DI3	7	100.0	ISC DEGRADATION FACTOR (PERCENT)
DI4	8	100.0	ISC DEGRADATION FACTOR (PERCENT)
DV1	9	95.0	VPM DEGRADATION FACTOR (PERCENT)
DV2	10	100.0	VPM DEGRADATION FACTOR (PERCENT)
AVPM0	11	0.460	VPM OF UNDEGRADED CELL (VOLTS)
AIPM0	12	0.113	IPM OF UNDEGRADED CELL (AMPS)
AVOC0	13	0.577	VOC OF UNDEGRADED CELL (VOLTS)
THETA	14	95.0	VOC DEGRADATION FACTOR (PERCENT)
TNOT	15	30.0	SOLAR CELL REFERENCE TEMP. (DEG.C)
ADIODE	16	1.0	ARRAY BLOCKING DIODE DROP (VOLTS)
DELTT	17	10.0	TEMP. INCREMENT FOR STASH STORAGE (DEG.C)
ADDT	18	45.0	HIGHEST STASH TEMP. MINUS TNOT (DEG.C)
FLUX	19	-1.0	DENI 1-MEV ELECTRON FLUX (ELEC/SD.CM.)
CG	20	6.0	COVER GLASS THICKNESS (MILS)
BS	21	15.0	BACKSHIELDING THICKNESS (MILS. OF ALUM.)
BOHMS	22	1.0	SOLAR CELL BASE RESISTIVITY (OHM-CM)
NDGRAD	23	1.0	INITIALIZE STASH (1.0 OR 0.0)
NENI	24	2.0	END OF RUNS KEY (1.0, 2.0, 3.0 OR 4.0)
	1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 17 18 19 20 21 22 23 24 25 26 27 28 29 30 31 32 33 34 35 36 37 38 39 40 41 42 43 44 45 46 47 48 49 50 51 52 53 54 55 56 57 58 59 60 61 62 63 64		

Figure 12. Format and Description of NCODES



calculating up to a maximum of 20 solar array I-V curves for each run. If the value of DELTAT is made larger than the value of TD (NCODE 1), only one solar array curve (at 0 minutes) will be computed.

- c. SIGISC is the solar cell short circuit current temperature coefficient.
- d. SIGVOC is the solar cell open-circuit voltage temperature coefficient and is punched on the card as a positive number; the program later gives it the proper negative sign.
- e. DI1 is the first short circuit current degradation factor; it usually refers to a standard cell error.
- f. DI2 is the second short circuit current degradation factor; it usually refers to a solar illumination intensity variation.
- g. DI3 is the third short circuit current degradation factor; it usually refers to ultraviolet degradation.
- h. DI4 is the fourth short circuit current degradation factor; it usually refers to a current measurement error.
- i. DV1 is the first maximum power point voltage degradation factor; it usually refers to an external series wiring loss.
- j. DV2 is the second maximum power point degradation factor; it usually refers to a thermal cycling degradation loss.
- k. AVPMO is the maximum power point voltage of the input, undegraded solar cell.
- l. AIPMO is the maximum power point current of the input, undegraded solar cell.
- m. AVOCO is the open circuit voltage of the input, undegraded solar cell.
- n. THETA is the open circuit voltage degradation factor; it usually refers to a voltage measurement error.
- o. TNOT is the input solar cell reference temperature (Deg. C).
- p. ADIODE is the array blocking diode voltage drop, specified by user. A value of 0.0 is punched if no blocking diode drop is desired in the output solar array curves.

- q. DELTT is the temperature increment (Deg. C) between solar cell I-V curve calculations in STASH.
- r. ADDT is the temperature increment (Deg. C) to be added to TNOT to determine the highest STASH temperature.
- s. FLUX is punched as 0.0 if no charged particle irradiation damage is to be considered, in which case Subroutines PHI and DEGRAD do not compute. If FLUX has a value of 1-Mev equivalent flux (Example:  $2.6 \times 10^{14}$  is punched as 26000000000000.0 on the card) subroutine PHI is bypassed and subroutine DEGRAD will degrade the solar cell for the specified 1-Mev flux. If FLUX is given a value of -1.0, subroutine PHI will compute a value of 1-Mev flux from tables of omnidirectional particle fluxes that the user must supply in table locations 3, 4, 5, and 6. This computed 1-Mev flux will then be automatically sent to subroutine DEGRAD for the appropriate solar cell corrections.
- t. CG is the solar cell coverglass thickness in mils of fused silica.
- u. BS is the equivalent solar cell backshielding thickness in mils of aluminum.
- v. BOHMS is the solar cell base resistivity (ohm-cm).
- w. NDGRAD must be set to 1.0 in the first run. This causes the machine to automatically degrade the solar cell and expand it for temperature in subroutine STASH as specified by the degradation and temperature parameters in the NCODES. When chaining additional runs, if the solar cell degradations are not changed, NDGRAD should be set to 0.0 in the second run. By setting NDGRAD to 0.0, needless repetitive computations in the solar cell subroutines are eliminated.
- x. NEND must be set to either 1.0, 2.0, 3.0, or 4.0 for each run, and determines which of the following options is selected:
  - NEND = 1.0 Do solar cell calculations only (PHI, DEGRAD and STASH) and stop.
  - NEND = 2.0 Do solar cell calculations and read new set of run instructions.
  - NEND = 3.0 Do solar cell and solar array calculations and stop.
  - NEND = 4.0 Do solar cell and solar array calculations and read new set of run instructions.

If no solar array calculations are to be made ( $NEND = 1.0$  or  $2.0$ ), a blank card must follow NCODE 24. This tells the computer to stop reading in data and to start computing. If no additional (chained) run is to be made, this blank card is the last card in the data deck.

#### Array Signal Card

If NCODE 24 has been punched with a 3.0 or a 4.0, immediately following the NCODE 24 card must be a card containing 999 in columns 1-3. This card tells the computer that solar array information is to follow.

#### NPANEL Card

Following the Array Signal Card is the NPANEL card, which contains the number (NPANEL) of solar panels in the array (maximum number of panels is 25). This number must appear right-justified in columns 1-3; no decimal point is required.

#### Panel Description Cards

Following the NPANEL card is a panel description card for each solar panel in the array, up to a maximum of 25 panels. The number of these panel description cards must agree with the value of NPANEL. Each card contains four fields of ten columns each, in floating point format (requires decimal point).

<u>Columns</u>	<u>Variable</u>	<u>Typical Value</u>
1-10	No. of Series Solar Cells per String	100.0
11-20	No. of Parallel Strings per Panel	10.0
21-30	Panel Incidence Angle vs. Time Table Location in STINT	11.0
31-40	Panel Temperature vs. Time Table Location in STINT	12.0

Following the Panel Description Cards is a blank card. This tells the computer to stop reading in data and to start computing. If it is desired to chain an additional run, a new Run Label Card and only those NCODES and Panel Description Cards that contain changed or new information should be placed after the blank card. As many runs as are desired can be chained in this manner, ensuring that each new run starts with a Run Label Card and ends with a blank card. Refer again to Figure 9 for the proper sequence of card positions for chained runs.

#### IV. PROGRAM OUTPUT

The information that the computer prints out after a run consists of the following items:

1. Stint Table Listing Option: There is an option in the program to list all the STINT tables. This is done by taking the date card at the beginning of the data package and either punching a one (1) or a zero (0) in column 9. Punching a one (1) will produce a listing of the STINT tables. A zero (0) will not produce a listing of the STINT tables.
2. Input Data Page:
  - a. Run number and date
  - b. Run comments (as specified on input cards)
  - c. Listing of NCODE numbers, names and values
  - d. Solar array description: panel number, number of series solar cells, number of parallel solar cell strings, number of STINT table which contains the solar illumination incidence angle, number of STINT table which contains the array temperature-time profile
3. Subroutine PHI:
  - a. The computed electron flux
  - b. The computed proton flux
  - c. The computed solar flare proton flux
  - d. The computed solar flare alpha particle flux
  - e. The computed total flux

The fluxes are in equivalent 1-Mev electrons/cm<sup>2</sup>
4. Subroutine DEGRAD
  - a. The solar cell I-V curve (irradiation degraded)
  - b. Short circuit current

- c. Current at the maximum power point
  - d. Voltage at the maximum power point
  - e. Open circuit voltage
5. Subroutine STASH: Values of temperature for which the degraded solar cell I-V curve has been prepared are listed in a row across the page. Values of maximum-power voltage and current, open circuit voltage and short-circuit current appear in columns under each temperature. Values of every other calculated current and voltage pair comprising the I-V curve and stored in the computer memory, are listed in columns under each temperature (in 20 mv increments).
6. Solar Array Data:
- a. Value of blocking diode voltage drop.
  - b. Time in orbit sunlight (up to 20 time increments starting with 0.0 min.).
  - c. Solar array voltage in one-volt steps from 0 volts to open-circuit voltage.
  - d. Total solar array current at each voltage above for each time increment; a maximum of 20 solar array I-V curves can be produced per computer run.

## V. SUMMARY

A computer program has been described which accounts for all factors that affect the power output of a solar cell. Charged particle irradiation degradation, external series resistance, illumination intensity variation and temperature effects are taken into account. Using the fully degraded solar cell characteristic as a basis, the program will determine the total I-V curve of solar arrays consisting of up to 25 separate panels. Each panel may have its own series-parallel solar cell arrangement, temperature versus time profile and solar incidence angle versus time profile.

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4. Cherry, W. R. and R. L. Statler, "Photovoltaic Properties of U.S. and European Silicon Cells under 1-Mev Electron Irradiation," GSFC Document No. X-716-68-204, April 1968.
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## GLOSSARY

- DELI - decrease in short circuit current caused by current degradation factors; used in STASH.
- DELV - decrease in open circuit voltage caused by the voltage degradation factor; used in STASH.
- $I_i$  - any particular current value of input I-V curve.
- ISCO - initial, undegraded value of short circuit current.
- $I_1$  - radiation degraded value of short circuit current; used in STASH.
- $I_2$  - degraded value of short circuit current; used in STASH.
- KD - arbitrary damage factor

- KDA - alpha particle damage factor; used in PHI.
- KDE - electron damage factor; used in PHI.
- KDP - proton damage factor; used in PHI.
- Ne - number of electrons in a given energy range; used in PHI.
- N<sub>fa</sub> - number of solar-flare alpha particles in a given energy range; used in PHI.
- N<sub>fp</sub> - number of solar-flare protons in a given energy range; used in PHI.
- N<sub>p</sub> - number of protons in a given energy range; used in PHI.
- PZCD - degraded point of zero current; a temporary parameter used in DEGRAD.
- PZCU - undegraded point of zero current; the initial value of open-circuit voltage used in DEGRAD.
- RI - relative short circuit current degradation factor; used in DEGRAD.
- RR - radiation resistance, defined as VISC/ISCO; used in DEGRAD.
- RV - relative open circuit voltage degradation factor; used in DEGRAD.
- Vi - any particular voltage point on input I-V curve.
- VISC - volts at short circuit current; used in DEGRAD.
- VOGR - degraded value of open circuit voltage; used in DEGRAD.
- VOC - degraded value of open circuit voltage; used in STASH.
- V<sub>pmo</sub> - initial value of maximum power point voltage; used in STASH.
- V<sub>pmr</sub> - the degraded value of maximum power point voltage; used in STASH.
- V<sub>1</sub> - radiation degraded value of open circuit voltage; used in STASH.
- V<sub>2</sub> - degraded value of open circuit voltage; used in STASH.

- $\Delta I$  - decrease in short circuit current caused by the equivalent flux, defined as ISCO-ISCR; used in DEGRAD.
- $\varphi_e$  - electron 1-Mev equivalent flux.
- $\varphi_f$  - solar-flare alpha particle 1-Mev equivalent flux.
- $\varphi_{fp}$  - solar-flare proton 1-Mev equivalent flux.
- $\varphi_p$  - proton 1-Mev equivalent flux.
- $\varphi_T$  - total 1-Mev equivalent flux.

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# Appendix A

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C**** SOLAR ARRAY SYNTHESIS PROGRAM DEVELOPED FOR NASA (GSFC) BY RCA-AED01 00010
C**** PROGRAMMERS R.RASMUSSEN, P.J.HYLAND, JUNE 1968 01 00020
      DIMENSION NDATE(3) 01 00030
      DIMENSION T(20) 01 00040
      DIMENSION XIA(20,100) 01 00050
      DIMENSION XC(25),XS(25),NANGLE(25),NTEMPS(25) 01 00060
C**** READ DATE 01 00070
      IA=5 01 00080
      IB=6 01 00090
      READ (IA,7000)NDATE(1),NDATE(2),NDATE(3),NLIST 01 00100
      CALL SLITE (0) 01 00110
      NRUN=1 01 00120
      DO 6001 I=1,25 01 00130
        XC(I)=0.0 01 00140
        XS(I)=0.0 01 00150
        NANGLE(I)=0 01 00160
6001 NTEMPS(I)=0 01 00170
      TD=0.0 01 00180
      DELTAT=1000.0 01 00190
      SIGISC=0.0 01 00200
      SIGVOC=0.0 01 00210
      DI1=100.0 01 00220
      DI2=100.0 01 00230
      DI3=100.0 01 00240
      DI4=100.0 01 00250
      DV1=100.0 01 00260
      DV2=100.0 01 00270
      AVPMO=0.0 01 00280
      AIPMO=0.0 01 00290
      AVOCO=0.0 01 00300
      THETA=100.0 01 00310
      TNOT=0.0 01 00320
      ADIODE=0.0 01 00330
      DELTT=0.0 01 00340
      ADDT=0.0 01 00350
      FLUX=0.0 01 00360
      CG=0.0 01 00370
      BS=0.0 01 00380
      BOHMS=0.0 01 00390
      NDGRAD=0 01 00400
      NEND=0 01 00410
      NCELLT=1 01 00420
      NKOST=2 01 00430
      NELECT=3 01 00440
      NPROTT=4 01 00450
      NFLARE=5 01 00460
      NALPHA=6 01 00470
      NKDE=7 01 00480
      NKDP=8 01 00490
      NKDA=9 01 00500
      NMVTBL=10 01 00510
      NKDFL=8 01 00520
      KEY=NLIST-1 01 00530
C**** READ TABLES COMMENT CARD 01 00540
      100 READ (IA,7001) 01 00550
C**** LOAD STINT TABLES 01 00560
      CALL STINT (0.0,0.0,0.0,0.0,0.0,KEY,NGRIPE,0,0) 01 00570
      IF (NGRIPE) 101,101,102 01 00580
      102 WRITE (IB,7001) 01 00590
      WRITE (IB,7002) 01 00600
      PRINT 7002 01 00610
      CALL EXIT 01 00620
C**** READ RUN COMMENTS CARD 01 00630
      101 READ (IA,7003) 01 00640
C**** PRINT HEADER CARD 01 00650
      WRITE (IB,7004)NRUN,(NDATE(J),J=1,3) 01 00660

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WRITE (IB,7001)	01 00670
WRITE (IB,7005)	01 00680
WRITE (IB,7003)	01 00690
WRITE (IB,7006)	01 00700
C**** READ INPUT DATA,NCODES	01 00710
103 READ (IA,7007)NCODE,PARAM	01 00720
IF (NCODE-999) 1103,106,1103	01 00730
1103 IF (NCODE) 105,105,5000	01 00740
106 READ (IA,7007)NPANEL	01 00750
DO 6000 K=1,NPANEL	01 00760
READ (IA,6600)P1,P2,P3,P4	01 00770
6600 FORMAT(10F10.5)	01 00780
XC(K)=P1	01 00790
XS(K)=P2	01 00800
NANGLE(K)=P3+.01	01 00810
NTEMPS(K)=P4+.01	01 00820
6000 WRITE (IB,6601)K,XC(K),XS(K),NANGLE(K),NTEMPS(K)	01 00830
6601 FORMAT (7HOPANEL 13/ 16H SERIES CELLS = F5.1,20H PARALLEL STRINGS	01 00840
1 = F6.2,15H ANGLE TABLE = 12,14H TEMP TABLE = 12)	01 00850
WRITE (IB,6602)	01 00860
6602 FORMAT (1H0)	01 00870
GO TO 103	01 00880
5000 GO TO (1,2,3,4,5,6,7,8,9,10,11,12,13,14,15,16,17,18,19,20,	01 00890
121,22,23,24,25),NCODE	01 00900
1 TD=PARAM	01 00910
WRITE (IB,201)NCODE,TD	01 00920
GO TO 103	01 00930
2 DELTAT=PARAM	01 00940
WRITE (IB,202)NCODE,DELTAT	01 00950
GO TO 103	01 00960
3 SIGISC=PARAM	01 00970
WRITE (IB,203)NCODE,SIGISC	01 00980
GO TO 103	01 00990
4 SIGVOC=PARAM	01 01000
WRITE (IB,204)NCODE,SIGVOC	01 01010
GO TO 103	01 01020
5 DI1=PARAM	01 01030
WRITE (IB,205)NCODE,DI1	01 01040
GO TO 103	01 01050
6 DI2=PARAM	01 01060
WRITE (IB,206)NCODE,DI2	01 01070
GO TO 103	01 01080
7 DI3=PARAM	01 01090
WRITE (IB,207)NCODE,DI3	01 01100
GO TO 103	01 01110
8 DI4=PARAM	01 01120
WRITE (IB,208)NCODE,DI4	01 01130
GO TO 103	01 01140
9 DV1=PARAM	01 01150
WRITE (IB,209)NCODE,DV1	01 01160
GO TO 103	01 01170
10 DV2=PARAM	01 01180
WRITE (IB,210)NCODE,DV2	01 01190
GO TO 103	01 01200
11 AVPMO=PARAM	01 01210
WRITE (IB,211)NCODE,AVPMO	01 01220
GO TO 103	01 01230
12 AIPMO=PARAM	01 01240
WRITE (IB,212)NCODE,AIPMO	01 01250
GO TO 103	01 01260
13 AVOCO=PARAM	01 01270
WRITE (IB,213)NCODE,AVOCO	01 01280
VOCO1=AVOCO	01 01290
GO TO 103	01 01300
14 THETA=PARAM	01 01310
WRITE (IB,214)NCODE,THETA	01 01320

THETA=THETA/100.0	01 01330
GO TO 103	01 01340
15 TNOT=PARAM	01 01350
WRITE (IB,215)NCODE,TNOT	01 01360
GO TO 103	01 01370
16 ADIODE=PARAM	01 01380
WRITE (IB,216)NCODE,ADIODE	01 01390
GO TO 103	01 01400
17 DELTT=PARAM	01 01410
WRITE (IB,217)NCODE,DELTT	01 01420
GO TO 103	01 01430
18 ADDT=PARAM	01 01440
WRITE (IB,218)NCODE,ADDT	01 01450
GO TO 103	01 01460
19 FLUX=PARAM	01 01470
WRITE (IB,219)NCODE,FLUX	01 01480
GO TO 103	01 01490
20 CG=PARAM	01 01500
WRITE (IB,220)NCODE,CG	01 01510
GO TO 103	01 01520
21 BS=PARAM	01 01530
WRITE (IB,221)NCODE,BS	01 01540
GO TO 103	01 01550
22 BOHMS=PARAM	01 01560
WRITE (IB,222)NCODE,BOHMS	01 01570
GO TO 103	01 01580
23 NDGRAD=PARAM+.01	01 01590
WRITE (IB,223)NCODE,NDGRAD	01 01600
GO TO 103	01 01610
24 NEND=PARAM+.01	01 01620
WRITE (IB,224)NCODE,NEND	01 01630
GO TO 103	01 01640
25 CONTINUE	01 01650
GO TO 103	01 01660
C**** END DATA LOADER	01 01670
C**** HOUSEKEEPING FOLLOWS	01 01680
105 IF (NDGRAD) 70,501,70	01 01690
70 DISC=(DI1/100.)*(DI2/100.)*(DI3/100.)*(DI4/100.)	01 01700
DV =(DV1/100.)*(DV2/100.)	01 01710
IF(BOHMS-5.0)81,81,82	01 01720
81 DENFAC=0.065	01 01730
GO TO 83	01 01740
82 DENFAC=0.0	01 01750
83 PHITOT=FLUX	01 01760
IF(FLUX)71,73,72	01 01770
71 CALL PHI (CG,BS,NKDE,NKDP,NKDFL,NELECT,NPROTT,NFLARE,	01 01780
INALPHA,NKDA,PHITOT)	01 01790
FLUX=PHITOT	01 01800
72 CALL DEGRAD (PHITOT,BOHMS,NCELLT,NMVTBL)	01 01810
CALL SLITE (1)	01 01820
C**** INITIAL ENTRY INTO SUBROUTINE STASH,INITIALIZATION	01 01830
73 CALL STASH (DISC,THETA,AVPMO,AIPMO,TNOT,-1,NGRIPE,NCELLT,VOCOI,	01 01840
1ADDT,DELTT)	01 01850
C**** SECOND ENTRY INTO SUBROUTINE STASH,INITIALIZATION	01 01860
CALL STASH (DV,DISC,SIGISC,SIGVOC,TNOT,0,NGRIPE,NCELLT,DENFAC,ADDT	01 01870
1,DELTT)	01 01880
IF(NGRIPE)74,76,74	01 01890
74 WRITE (IB,7009)	01 01900
CALL EXIT	01 01910
76 GO TO (80,30,501,501),NEND	01 01920
30 NRUN=NRUN+1	01 01930
GO TO 101	01 01940
80 CONTINUE	01 01950
CALL EXIT	01 01960

201	FORMAT (17,50H TD,ORBIT SUNTIME DURATION (MINUTES)	01	01970
	1F12.4)	01	01980
202	FORMAT (17,50H DELTAT,TIME BETWEEN CALCULATIONS (MINUTES)	01	01990
	1F12.4)	01	02000
203	FORMAT (17,50H SIGISC,ISC TEMP. COEF.(AMPS/DEG.C)	01	02010
	1F12.6)	01	02020
204	FORMAT (17,50H SIGVOC,VOC TEMP. COEF.(VOLTS/DEG.C)	01	02030
	1F12.6)	01	02040
205	FORMAT (17,50H DI1,ISC DEGRADATION FACTOR (PERCENT)	01	02050
	1F12.4)	01	02060
206	FORMAT (17,50H DI2,ISC DEGRADATION FACTOR (PERCENT)	01	02070
	1F12.4)	01	02080
207	FORMAT (17,50H DI3,ISC DEGRADATION FACTOR (PERCENT)	01	02090
	1F12.4)	01	02100
208	FORMAT (17,50H DI4,ISC DEGRADATION FACTOR (PERCENT)	01	02110
	1F12.4)	01	02120
209	FORMAT (17,50H DV1,VPM DEGRADATION FACTOR (PERCENT)	01	02130
	1F12.4)	01	02140
210	FORMAT (17,50H DV2,VPM DEGRADATION FACTOR (PERCENT)	01	02150
	1F12.4)	01	02160
211	FORMAT (17,50H AVPMO,VPM OF UNDEGRADED CELL (VOLTS)	01	02170
	1F12.4)	01	02180
212	FORMAT (17,50H AIPMO,IPM OF UNDEGRADED CELL (VOLTS)	01	02190
	1F12.4)	01	02200
213	FORMAT (17,50H AVOCO,VOC OF UNDEGRADED CELL (VOLTS)	01	02210
	1F12.4)	01	02220
214	FORMAT (17,50H THETA,VOC DEGRADATION FACTOR (PERCENT)	01	02230
	1F12.4)	01	02240
215	FORMAT (17,50H TNOT,SOLAR CELL REFERENCE TEMP.(DEG.C)	01	02250
	1F12.4)	01	02260
216	FORMAT (17,50H ADIODE,ARRAY BLOCKING DIODE DROP (VOLTS)	01	02270
	1F12.4)	01	02280
217	FORMAT (17,50H DELTT, TEMP. INCREMENT FOR STASH STORAGE (DEG.C)	01	02290
	1F12.4)	01	02300
218	FORMAT (17,50H ADDT, HIGHEST STASH TEMP. MINUS TNOT (DEG.C)	01	02310
	1F12.4)	01	02320
219	FORMAT (17,50H FLUX,DEN1 1-MEV ELECTRON FLUX (ELEC/SQ.CM.)	01	02330
	1E12.4)	01	02340
220	FORMAT (17,50H CG,COVER GLASS THICKNESS (MILS)	01	02350
	1F12.4)	01	02360
221	FORMAT (17,50H BS,BACKSHIELDING THICKNESS (MILS. OF ALUM.)	01	02370
	1F12.4)	01	02380
222	FORMAT (17,50H BOHMS,SOLAR CELL BASE RESISTIVITY (OHM-CM)	01	02390
	1F12.4)	01	02400
223	FORMAT (17,50H NDGRAD,INITIALIZE STASH (1.0 OR 0.0)	01	02410
	118)	01	02420
224	FORMAT (17,50H NEND,END OF RUNS KEY (1.0,2.0,3.0 OR 4.0)	01	02430
	118)	01	02440
225	FORMAT (17,50H NLIST,STINT TABLE LISTING OPTION (1.0 OR 0.0)	01	02450
	118)	01	02460
C****	FORMATS	01	02470
7000	FORMAT (312,2X,11)	01	02480
7001	FORMAT (72H	01	02490
	1 )	01	02500
7002	FORMAT (34H UNABLE TO READ TABLES, ABORT RUN)	01	02510
7003	FORMAT (72H	01	02520
	1 )	01	02530
7004	FORMAT (12H1 RUN NO.13,18H ON THIS DATE OF 12,1H-12,1H-12,75H	01	02540
	1 SOLAR ARRAY SYNTHESIS PROGRAM	01	02550
	2 /20H0 TABLE COMMENTS.)	01	02560
7005	FORMAT (18H0 RUN COMMENTS.)	01	02570
7006	FORMAT (30H0 NEW OR CHANGED PARAMETERS/1H0)	01	02580
7007	FORMAT (13,1X,F20.0)	01	02590
7008	FORMAT (35H0 ERROR IN TABLE LOOKUP, NGR1PE =11)	01	02600
7009	FORMAT (25H STASH DID NOT INITIALIZE)	01	02610
C****	START SOLAR ARRAY COMPUTATIONS	01	02620

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501 DO 503 INCR=1,20
    DO 503 JVOLT=1,100
    XIA(INCR,JVOLT) = 0.0
503 CONTINUE
    T(1) = 0.0
    INCR = 1
    GO TO 599
502 T(INCR+1) = T(INCR) + DELTAT
    IF (TD - T(INCR+1)) 700,505,505
505 INCR = INCR + 1
    IF (20 - INCR) 700,599,599
C**** K IS PANEL NUMBER
599 K=1
600 CALL STINT (T(INCR),0.0,0.0,PANANG,1,NGRIPE,NANGLE(K),NANGLE(K))
    IF (NGRIPE)690,601,690
690 NGRIPE=1
    GO TO 1000
601 CALL STINT (T(INCR),0.0,0.0,PTEMP,1,NGRIPE,NTEMPS(K),NTEMPS(K))
    IF (NGRIPE)691,602,691
691 NGRIPE=2
    GO TO 1000
602 CALL STINT(PANANG,0.0,0.0,EFFECT,1,NGRIPE,2,2)
    IF (NGRIPE)692,603,692
692 NGRIPE=3
    GO TO 1000
603 JVOLT=1
    IF (EFFECT) 607,607,604
604 AVOLT=FLOAT (JVOLT)-1.0*ADIODE
    ARG1=AVOLT/XC(K)
    IF (JVOLT-1)610,610,611
C**** GET VALUE OF FULL INTENSITY ISC FROM STASH
610 CALL STASH(TLU,0.0,0.0,PTEMP,0.0,1,0.0,0.0,0.0,DELTT)
    DELI=TLU*(1.0-EFFECT)
    PHIL=1.0/EFFECT
    DELVOC=(0.026*(273.0+PTEMP)/300.0)*ALOG (PHIL)
C**** GET VALUE OF FULL INTENSITY VOC FROM STASH
    CALL STASH(OCV,0.0,0.0,PTEMP,0.0,989,0.0,0.0,0.0,DELTT)
C**** GET VALUE OF VOLTAGE AT CURRENT DELI FROM STASH
    CALL STASH(VAI,0.0,DELI,PTEMP,0.0,988,0.0,0.0,0.0,DELTT)
    DELTAV=OCV-VAI-DELVOC
611 IF (ARG1-DELTAV)606,605,605
605 ARG1=ARG1-DELTAV
606 CALL STASH(CELLI,0.0,ARG1,PTEMP,0.0,1,0.0,0.0,0.0,DELTT)
    PANELI=XS(K)*(CELLI-DELI)
    IF (PANELI)607,607,609
607 PANELI=0.0
608 K=K+1
    IF (NPANEL-K)502,600,600
609 XIA(INCR,JVOLT)=XIA(INCR,JVOLT)+PANELI
    JVOLT=JVOLT+1
    IF (100-JVOLT)608,604,604
1000 WRITE (18,7008)NGRIPE
    CALL EXIT
700 WRITE (18,9000)ADIODE
    T(INCR+1)=0.0
    IBEG=1
    IEND=10
    DO 400 K=1,2
    AVOLT=0.0
    WRITE (18,9001)(T(INCR),INCR=IBEG,IEND)
401 DO 410 J=1,100
    WRITE (18,9002)AVOLT,(XIA(INCR,J),INCR=IBEG,IEND)
    AVOLT=AVOLT+1.0
402 DO 420 L=IBEG,IEND
    IF (XIA(L,J)-0.0)410,420,410
420 CONTINUE

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01 02740
01 02750
01 02760
01 02770
01 02780
01 02790
01 02800
01 02810
01 02820
01 02830
01 02840
01 02850
01 02860
01 02870
01 02880
01 02890
01 02900
01 02910
01 02920
01 02930
01 02940
01 02950
01 02960
01 02970
01 02980
01 02990
01 03000
01 03010
01 03020
01 03030
01 03040
01 03050
01 03060
01 03070
01 03080
01 03090
01 03100
01 03110
01 03120
01 03130
01 03140
01 03150
01 03160
01 03170
01 03180
01 03190
01 03200
01 03210
01 03220
01 03230
01 03240
01 03250
01 03260
01 03270
01 03280

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GO TO 430	01 03290
410 CONTINUE	01 03300
430 IBEG=11	01 03310
IEND=20	01 03320
WRITE (IB,9003)	01 03330
400 CONTINUE	01 03340
NRUN=NRUN+1	01 03350
GO TO (80,80,80,101),NEND	01 03360
9000 FORMAT (60H1	01 03370
1TH (F4.2,28H) VOLTS BLOCKING DIODE DROP )	01 03380
9001 FORMAT (/17H TIME IN SUNLIGHT/11H (MINUTES)10F10.2, //51X,16HCURRE	01 03390
INT(AMPERES)/2X,5HVOLTS)	01 03400
9002 FORMAT (F5.1,6X,10F10.2)	01 03410
9003 FORMAT (1H1)	01 03420
END	01 03430
SUBROUTINE STINT (ARG1,ARG2,ARG3,FCT,KEY,NGRIPE,MINTBL,MAXTBL)	02 00020
DIMENSION NUMPTS(61),L1(60),L2(60),L3(60),STG(3600),DUMMY(10)	02 00030
DIMENSION NAME (14)	02 00040
EQUIVALENCE (NAT,L3(1))	02 00050
C**** SIZE OF STG IS CALCULATED BY SUM OF ((1+N(ARG1))*(1+N(ARG2)))	02 00060
IA=5	02 00070
IB=6	02 00080
NGRIPE=0	02 00090
IF (KEY) 1,1,70	02 00100
646 FORMAT(1X,10E11.4,12)	02 00110
1 NG=1	02 00120
NORMAL=1	02 00130
WRITE (IB,1357)	02 00140
1357 FORMAT (34H0 TABLE           DATE           CONTENTS)	02 00150
GO TO 55	02 00160
2000 NG=2	02 00170
NORMAL=2	02 00180
WRITE (IB,1257)	02 00190
1257 FORMAT (1H1)	02 00200
3000 RETURN	02 00210
775 NGRIPE=1	02 00220
RETURN	02 00230
776 NGRIPE=2	02 00240
WRITE (IB,9000)ARG1,ARG2,ARG3,MINTBL,MAXTBL	02 00250
RETURN	02 00260
9000 FORMAT (20H0 ERROR IN TLU,ARG1=E12.5,6H ARG2=E12.5,6H ARG3=E12.5,	02 00270
18H MINTBL=14,8H MAXTBL=14)	02 00280
C BEGINNING OF STINT	02 00290
55 NUMTBL=1	02 00300
NUMPTS(1)=0	02 00310
102 READ (IA,57)DA1,DA2,DA3,K,L1(NUMTBL),L2(NUMTBL),NAME, ISEQ	02 00320
57 FORMAT (A2,A3,A3,14,212,13A4,A2,12)	02 00330
WRITE (IB,1157)K,DA1,DA2,DA3,NAME	02 00340
1157 FORMAT (/18,5X,A2,A3,A3,5X,13A4,A2)	02 00350
104 IF(ISEQ) 69,58,69	02 00360
58 IF (K) 99,99,1159	02 00370
1159 IF (K-60) 59,59,1103	02 00380
59 L8=L1(NUMTBL)	02 00390
N1=(L8-1)/9+1	02 00400
DO 68 IS=1,N1	02 00410
NAT=(IS-1)*9+1	02 00420
IF (IS-N1) 60,61,60	02 00430
60 L4=NAT+8	02 00440
GO TO 62	02 00450
61 L4=L8	02 00460
62 L5=NUMPTS(NUMTBL)+1	02 00470
L6=L5+NAT	02 00480
L7=L5+L4	02 00490
JJ=0	02 00500
L9=L2(NUMTBL)	02 00510
LM=L5+L8	02 00520

LN=LM+L9	02 00530
105 READ (1A,64)(DUMMY(K),K=1,10),ISEQ	02 00540
64 FORMAT (10E7.0,12)	02 00550
IF (KEY) 107,11,11	02 00560
11 WRITE (1B,646)(DUMMY(K),K=1,10),ISEQ	02 00570
107 STG(L5)=DUMMY(1)	02 00580
K=2	02 00590
DO 65 J=L6,L7	02 00600
STG(J)=DUMMY(K)	02 00610
65 K=K+1	02 00620
IF (ISEQ-((IS-1)*(L9+1)+JJ+1)) 69,66,69	02 00630
66 L6=LN+NAT	02 00640
L7=LN+L4	02 00650
L5=LM+1+JJ	02 00660
IF (JJ-L9) 67,68,69	02 00670
67 JJ=JJ+1	02 00680
LN=LN+L8	02 00690
GO TO 105	02 00700
68 CONTINUE	02 00710
109 LEE=NUMPTS(NUMTBL)+(L8+1)*(L9+1)	02 00720
IF (LEE-3600) 1100,1100,1101	02 00730
1100 IF (NUMTBL-60) 1102,108,1103	02 00740
1102 NUMPTS(NUMTBL+1)=LEE	02 00750
108 NUMTBL=NUMTBL+1	02 00760
GO TO 102	02 00770
1101 WRITE (1B,1111)LEE	02 00780
GO TO 775	02 00790
1103 WRITE (1B,1113)NUMTBL	02 00800
GO TO 775	02 00810
1111 FORMAT (17H TOO MANY POINTS 18)	02 00820
1113 FORMAT (17H TOO MANY TABLES 18)	02 00830
69 GO TO (775,776,776),NG	02 00840
70 IF (MINTBL-MAXTBL) 71,100,69	02 00850
71 DO 73 NAT=MINTBL,MAXTBL	02 00860
L4=NUMPTS(NAT)+1	02 00870
IF (ARG3-STG(L4)) 72,74,73	02 00880
72 IF (NAT-MINTBL) 69,69,75	02 00890
73 CONTINUE	02 00900
GO TO 69	02 00910
75 L5=1	02 00920
L6=2	02 00930
L7=L4	02 00940
101 DO 9, L8=L5,L6	02 00950
L4=NUMPTS(NAT)+1	02 00960
L9=L1(NAT)	02 00970
LM=L9+L4	02 00980
DO 77 LN=1,L9	02 00990
JJ=L4+LN	02 01000
2626 IF (ARG1-STG(JJ)) 76,78,77	02 01010
76 IF (LN-1) 69,69,79	02 01020
77 CONTINUE	02 01030
GO TO 69	02 01040
78 N1=-1	02 01050
GO TO 80	02 01060
79 N1=+1	02 01070
80 K=L2(NAT)	02 01080
DO 82 I=1,K	02 01090
IDATE=LM+I	02 01100
IF (ARG2-STG(IDATE)) 81,83,82	02 01110
81 IF (I-1) 69,69,84	02 01120
82 CONTINUE	02 01130
GO TO 69	02 01140
83 IS=-1	02 01150
GO TO 85	02 01160
84 IS=+1	02 01170
85 ISEQ=LM+L2(NAT)+LN+(I-1)*L9	02 01180

J=ISEQ-L9	02 01190
K8=LM+(I-1)	02 01200
K9=L4+LN-1	02 01210
IF (N1+IS) 86,88,91	02 01220
86 IF (STG(ISEQ)-999.E20) 87,69,69	02 01230
87 FCT=STG(ISEQ)	02 01240
GO TO 95	02 01250
88 IF (N1) 89,69,93	02 01260
89 IF (AMAX1 (STG(ISEQ),STG(J))-999.E20) 90,69,69	02 01270
90 FCT=STG(ISEQ)-(STG(IDE)-ARG2)*(STG(ISFQ)-STG(J))/(STG(IDE)-	02 01280
1-STG(K8))	02 01290
GO TO 95	02 01300
91 IF (AMAX1 (STG(ISEQ),STG(J),STG(ISEQ-1),STG(J-1))-999.E20) 92,	02 01310
1 69,69	02 01320
92 FCT=((STG(IDE)-ARG2)*((STG(JJ)-ARG1)*STG(J-1)-(STG(K9)-ARG1)	02 01330
1*STG(J))-(STG(K8)-ARG2)*((STG(JJ)-ARG1)*STG(ISEQ-1)-(STG(K9)-	02 01340
2ARG1)*STG(ISEQ)))/((STG(IDE)-STG(K8))*(STG(JJ)-STG(K9)))	02 01350
GO TO 95	02 01360
93 IF (AMAX1 (STG(ISEQ),STG(ISEQ-1))-999.E20) 94,69,69	02 01370
94 FCT=STG(ISEQ)-(STG(JJ)-ARG1)*(STG(ISEQ)-STG(ISEQ-1))/(STG(JJ)-	02 01380
1STG(K9))	02 01390
95 GO TO (96,98,99),L8	02 01400
96 DUMMY(1)=FCT	02 01410
97 NAT=NAT-1	02 01420
98 FCT=DUMMY(1)-(STG(L7)-ARG3)*(DUMMY(1)-FCT)/(STG(L7)-STG(L4))	02 01430
99 GO TO (2000,3000),NORMAL	02 01440
100 NAT=NINTBL	02 01450
74 LS=3	02 01460
LS=3	02 01470
GO TO 101	02 01480
C END STINT TABLE LOOK-UP	02 01490
END	02 01500
SUBROUTINE PHI (CG,BS,NKDE,NKDP,NKDFL,NELECT,NPROTT,NFLARE,	03 00020
INALPHA,NKDA,PHITOT)	03 00030
IA=5	03 00040
IB=6	03 00050
GLASS=CG/6.0	03 00060
SCBACK=BS/5.0	03 00070
PHIELE = 0.0	03 00080
PHIPRO = 0.0	03 00090
PHIFLR = 0.0	03 00100
PHIALP = 0.0	03 00110
PHITOT = 0.0	03 00120
C**** COMPUTE ELECTRON FLUX	03 00130
DO 1 I = 1,11	03 00140
DUM = FLOAT (I)	03 00150
CALL STINT (DUM,GLASS,0.0,XKDE,1,NGRIPE,NKDE,NKDE)	03 00160
CALL STINT (DUM,SCBACK,0.0,YKDE,1,NGRIPE,NKDE,NKDE)	03 00170
CALL STINT (DUM,0.0,0.0,XNE,1,NGRIPE,NELECT,NELECT)	03 00180
PHIELE = PHIELE + XNE*XKDE + XNE*YKDE	03 00190
IF (NGRIPE) 10,1,10	03 00200
10 NGRIPE = 5555	03 00210
GO TO 11	03 00220
1 CONTINUE	03 00230
C**** COMPUTE PROTON FLUX	03 00240
DO 2 I = 1,18	03 00250
DUM = FLOAT (I)	03 00260
CALL STINT (DUM,GLASS,0.0,XKDP,1,NGRIPE,NKDP,NKDP)	03 00270
CALL STINT (DUM,SCBACK,0.0,YKDP,1,NGRIPE,NKDP,NKDP)	03 00280
CALL STINT (DUM,0.0,0.0,XNP,1,NGRIPE,NPROTT,NPROTT)	03 00290
PHIPRO = PHIPRO + XNP*XKDP + XNP*YKDP	03 00300
IF (NGRIPE) 20,2,20	03 00310
20 NGRIPE = 6666	03 00320
GO TO 11	03 00330
2 CONTINUE	03 00340



C**** COMPUTE SOLAR FLARE PROTON FLUX	03 00350
DO 3 I = 1,18	03 00360
DUM = FLOAT (I)	03 00370
CALL STINT (DUM,GLASS,0.0,XKDL,1,NGRIPE,NKDFL,NKDFL)	03 00380
CALL STINT (DUM,SCBACK,0.0,YKDL,1,NGRIPE,NKDFL,NKDFL)	03 00390
CALL STINT (DUM,0.0,0.0,XNF,1,NGRIPE,NFLARE,NFLARE)	03 00400
PHIFLR = PHIFLR + XNF*XKDL + XNF*YKDL	03 00410
IF (NGRIPE) 30,3,30	03 00420
30 NGRIPE = 7777	03 00430
GO TO 11	03 00440
3 CONTINUE	03 00450
C**** COMPUTE SOLAR FLARE ALPHA PARTICLE FLUX	03 00460
DO 4 I = 1,18	03 00470
DUM = FLOAT (I)	03 00480
CALL STINT (DUM,GLASS,0.0,XKDA,1,NGRIPE,NKDA,NKDA)	03 00490
CALL STINT (DUM,SCBACK,0.0,YKDA,1,NGRIPE,NKDA,NKDA)	03 00500
CALL STINT (DUM,0.0,0.0,XNA,1,NGRIPE,NALPHA,NALPHA)	03 00510
PHIALP = PHIALP + XNA*XKDA + XNA*YKDA	03 00520
IF (NGRIPE) 40,4,40	03 00530
40 NGRIPE = 8888	03 00540
GO TO 11	03 00550
4 CONTINUE	03 00560
C**** COMPUTE TOTAL FLUX	03 00570
PHITOT = PHIELE + PHIPRO + PHIFLR + PHIALP	03 00580
WRITE (18,100)	03 00590
100 FORMAT (58H1 SUMMATIONS OF ELECTRON,PROTON, AND SOLAR FLARE PARTIC03 00600	
1LES//89H ELECTRONS PROTONS SOLAR FLARE PROTONS SOLA03 00610	
2R FLARE ALPHA PARTICLES TOTAL//)	03 00620
WRITE (18,101)PHIFLE,PHIPRO,PHIFLR,PHIALP,PHITOT	03 00630
101 FORMAT (1X,E12.4,2X,E12.4,E12.4,13X,E12.4,19X,E12.4)	03 00640
WRITE (18,102)	03 00650
102 FORMAT (54H0 NOTE, THESE FLUXES ARE IN EQUIVALENT 1 MEV ELECTRONS)03 00660	
RETURN	03 00670
11 WRITE (1P,103)NGRIPE	03 00680
CALL EXIT	03 00690
103 FORMAT (15H0 ERROR IN TLU 15)	03 00700
END	03 00710
SUBROUTINE DEGRAD (PHITOT,BOHMS,NCELLT,NMVTBL)	04 00020
DIMENSION VVEC(101),XIVEC(101)	04 00030
COMMON VVEC,XIVEC	04 00040
IA=5	04 00050
IB=6	04 00060
VVEC(1) = 0.0	04 00070
XIVEC(1) = 0.0	04 00080
DO 1 I = 2,101	04 00090
XIVEC(I) = 0.0	04 00100
1 VVEC(I) = VVEC(I-1) + 0.01	04 00110
DO 3 I = 1,101	04 00120
CALL STINT (VVEC(I),0.0,0.0,XIVEC(I),1,NGRIPE,NCELLT,NCELLT)	04 00130
IF (NGRIPE) 2,3,2	04 00140
2 WRITE (18,100)	04 00150
100 FORMAT (48H0 ERROR IN DEGRADATION ROUTINE TLU OF CELL CURVE)	04 00160
CALL EXIT	04 00170
3 CONTINUE	04 00180
C**** TLU OF MILLIVOLTS AT ISC VS. TOTAL FLUX AND BASE RESISTIVITY	04 00190
CALL STINT (PHITOT,BOHMS,0.0,XIV,1,NGRIPE,NMVTBL,NMVTBL)	04 00200
IF (NGRIPE) 4,5,4	04 00210
4 NGRIPE = NMVTBL	04 00220
WRITE (18,101)NGRIPE	04 00230
101 FORMAT (25H0 ERROR IN TLU, TABLE NO.15)	04 00240
C**** COMPUTE RR	04 00250
5 XISCO = XIVEC(1)	04 00260
RR = XMV/XISCO	04 00270
C**** CHANGE VVEC	04 00280
DO 6 I = 1,101	04 00290
VVEC(I) = VVEC(I) + XIVEC(I)*RR	04 00300

6 CONTINUE	04 00310
C**** FIND VOCO	04 00320
DO 7 I = 2,101	04 00330
N = 1	04 00340
IF (XIVEC(I)) 8,8,7	04 00350
7 CONTINUE	04 00360
8 SLOPE = (XIVEC(N-1)-XIVEC(N-2))/(VVEC(N-1)-VVEC(N-2))	04 00370
DO 9 J = N,101	04 00380
9 XIVEC(J) = XIVEC(N-1)+(VVEC(J)-VVEC(N-1))*SLOPE	04 00390
VOCO = VVEC(N-1) + XIVEC(N-1)*(VVEC(N)-VVEC(N-1))/(XIVEC(N-1)	04 00400
1 -XIVEC(N))	04 00410
C**** COMPUTE RI FOR TOTAL PHI	04 00420
IF (BOHMS - 1.0) 10,10,13	04 00430
10 IF (PHITOT - 1.0E15) 11,12,12	04 00440
11 IF (PHITOT - 4.0E12) 17,17,18	04 00450
12 RI = 3.3 - 0.167*0.4342944819*ALOG (PHITOT)	04 00460
GO TO 16	04 00470
13 IF (PHITOT - 1.0E15) 14,15,15	04 00480
14 IF (PHITOT - 5.0E12) 17,17,19	04 00490
15 RI = 2.806 - 0.1325*0.4342944819*ALOG (PHITOT)	04 00500
GO TO 16	04 00510
17 RI = 1.0	04 00520
GO TO 16	04 00530
18 RI = 1.0 - 7.13/((10.0)** 8.31)*((PHITOT-4.0E12)**0.451)	04 00540
GO TO 16	04 00550
19 RI = 1.0 - 2.78/((10.0)** 7.34)*((PHITOT-5.0E12)**0.41)	04 00560
C**** COMPUTE DELTA I	04 00570
16 DELTA I = XISCO*(1.0 - RI)	04 00580
C**** CHANGE XIVEC	04 00590
DO 20 I = 1,101	04 00600
XIVEC(I) = XIVEC(I) - DELTA I	04 00610
20 CONTINUE	04 00620
C**** FIND PZC, POINT OF ZERO CURRENT	04 00630
DO 21 I = 2,101	04 00640
N = 1	04 00650
IF (XIVEC(I)) 22,22,21	04 00660
21 CONTINUE	04 00670
22 SLOPE = (XIVEC(N-1)-XIVEC(N-2))/(VVEC(N-1)-VVEC(N-2))	04 00680
DO 23 J = N,101	04 00690
23 XIVEC(J) = XIVEC(N-1)+(VVEC(J)-VVEC(N-1))*SLOPE	04 00700
PZC = VVEC(N-1)+XIVEC(N-1)*(VVEC(N)-VVEC(N-1))/(XIVEC(N-1)	04 00710
1 -XIVEC(N))	04 00720
C**** COMPUTE RV FOR TOTAL PHI	04 00730
IF (PHITOT - 1.0E14) 25,24,24	04 00740
24 RV = 1.779 - 0.0588*0.4342944819*ALOG (PHITOT)	04 00750
GO TO 26	04 00760
25 IF (PHITOT - 3.0E12) 27,27,28	04 00770
27 RV = 1.0	04 00780
GO TO 26	04 00790
28 RV = 1.0 - 0.0222*((0.4342944819*ALOG (PHITOT/3.0E12))**1.67)	04 00800
C**** COMPUTE VOCR	04 00810
26 VOCR = VOCO*RV	04 00820
DELTAV = PZC - VOCR	04 00830
C**** FINAL UPDATE OF VOLTAGES IN ARRAY	04 00840
DO 30 I = 1,101	04 00850
VVEC(I) = VVEC(I) - DELTAV	04 00860
30 CONTINUE	04 00870
C**** COMPUTE ISCR,IPMR,VPMR	04 00880
31 DO 33 I = 1,101	04 00890
IF (VVEC(I)) 33,32,32	04 00900
32 XISCR = XIVEC(I)	04 00910
GO TO 34	04 00920
33 CONTINUE	04 00930
34 N = 1	04 00940
PWR = -1000000.0	04 00950
40 PWRT = VVEC(N)*XIVEC(N)	04 00960

IF (PWRT-PWR) 42,44,41	04 00970
41 N = N+1	04 00980
PWR = PWRT	04 00990
GO TO 40	04 01000
44 VPMR = VVEC(N)	04 01010
XIPMR = XIVEC(N)	04 01020
GO TO 45	04 01030
42 SLOPE = (XIVEC(N-1)-XIVEC(N))/(VVEC(N)-VVEC(N-1))	04 01040
43 VPMR = VVEC(N-1) + 0.00015	04 01050
XIPMR = XIVEC(N-1) - SLOPE*(VPMR - VVEC(N-1))	04 01060
PWRT = VPMR*XIPMR	04 01070
IF (PWRT-PWR) 45,45,48	04 01080
48 PWR = PWRT	04 01090
GO TO 43	04 01100
45 WRITE (IB,102)	04 01110
102 FORMAT (43H1 SOLAR CELL I-V CURVE IRRADIATION-DEGRADED)	04 01120
WRITE (IB,103)XISCR,XIPMR,VPMR,VOCR	04 01130
103 FORMAT (36H0 SHORT-CIRCUIT CURRENT (AMPS) = F10.6/36H0 CURREN	04 01140
1T AT MAX PWR PT (AMPS) = F10.6/36H0 VOLTAGE AT MAX PWR PT (VOLT	04 01150
2S) = F10.6/36H0 OPEN-CIRCUIT VOLTAGE (VOLTS) = F10.6//)	04 01160
WRITE (IB,105)	04 01170
105 FORMAT (20H0 DEGRADED I-V CURVE//17H VOLTS AMPS//)	04 01180
DO 46 I = 1,101,2	04 01190
WRITE (IB,106)VVEC(I),XIVEC(I)	04 01200
106 FORMAT (2F12.6)	04 01210
46 CONTINUE	04 01220
RETURN	04 01230
END	04 01240
SUBROUTINE STASH (SIGISC,SIGVOC,DISC,DV,TNOT,KEY,NGRIPE,NCELLT,	05 00020
1VOCOI,ADDT,DELTT)	05 00030
DIMENSION VVEC(101),XIVEC(101),TEMP(15),VMAP(15,101),XIMAP(15,101)	05 00040
DIMENSION VOCT(15),XISCT(15),VMP(15),XIMP(15)	05 00050
DIMENSION PWRSTG(15)	05 00060
COMMON VVEC,XIVEC	05 00070
C DECIDE IF INITIALIZATION OR COMPUTATION	05 00080
IA=5	05 00090
IB=6	05 00100
NGRIPE=0	05 00110
IF(KEY)2000,3000,1000	05 00120
C INITIALIZATION - OBTAIN I AND V INPUT VECTORS	05 00130
C *****	05 00140
C IN FIRST ENTRY	05 00150
C SIGISC IS DISC	05 00160
C SIGVOC IS THETA	05 00170
C DISC IS AVPMO	05 00180
C DV IS AIPMO	05 00190
C TNOT IS TNOT	05 00200
C KEY IS -1	05 00210
C NGRIPE IS NGRIPE	05 00220
C NCELLT IS NCELLT	05 00230
C VOCOI IS VOCOI	05 00240
C ADDT IS ADDT	05 00250
C DELTT IS DELTT	05 00260
2000 CALL SLITET (1, K001FX)	05 00270
GO TO (2005,5000), K001FX	05 00280
5000 VVEC(1)=0.0	05 00290
XIVEC(1)=0.0	05 00300
DO 2001 I=2,101	05 00310
XIVEC(I)=0.0	05 00320
2001 VVEC(I) = VVEC(I-1) + 0.010	05 00330
DO 2002 I = 1,100	05 00340
CALL STINT (VVEC(I),0.0,0.0,XIVEC(I),1,NGRIPE,NCELLT,NCELLT)	05 00350
IF(NGRIPE)2002,2002,2003	05 00360
2002 CONTINUE	05 00370
GO TO 2005	05 00380
2003 IF (XIVEC(I-1))2005,2005,12003	05 00390

12003	RETURN	05	00400
C	EXTRAPOLATE INPUT CURVE	05	00410
C	LOCATE FIRST ZERO ELEMENT IN XIVEC	05	00420
2005	DO 2107 I = 2,101	05	00430
	N=1	05	00440
	IF(XIVEC(I))2106,2106,2107	05	00450
2107	CONTINUE	05	00460
2106	SLOPE=(XIVEC(N-1)-XIVEC(N-2))/(VVEC(N-1)-VVEC(N-2))	05	00470
C	LOCATE POINT OF ZERO CURRENT FOR UNDEGRADED CURVE	05	00480
	PZCU = VVEC(1) - XIVEC(1)/SLOPE	05	00490
	DO 2108 J = N,101	05	00500
2108	XIVEC(J)=XIVEC(N-1)+(VVEC(J)-VVEC(N-1))*SLOPE	05	00510
C	DO CURRENT DEGRADATION WITH GAMMA,TNOT,THETA	05	00520
	XISC = XIVEC(1)	05	00530
	GAMMA=SIGISC	05	00540
	DELTA1=(1.0-GAMMA)*XISC	05	00550
	RECIP=1.0/GAMMA	05	00560
	THETA=SIGVOC	05	00570
	DELTA1=(TNOT+273.16)*0.8614E-04*ALOG (RECIP)	05	00580
	DELTA1 = DELTA1 + (1.0 - THETA)*VOC01	05	00590
	DO 2600 I = 1,101	05	00600
	XIVEC(I) = XIVEC(I) - DELTA1	05	00610
	IF (XIVEC(I)) 2703,2703,2600	05	00620
2703	KIX = I - 1	05	00630
	LOU = I - 1	05	00640
	DO 2622 L = LOU,101	05	00650
2622	XIVEC(L) = XIVEC(L) - DELTA1	05	00660
	GO TO 2600	05	00670
2600	CONTINUE	05	00680
2006	CONTINUE	05	00690
C	LOCATE POINT OF ZERO CURRENT FOR DEGRADED CURVE	05	00700
	SLOPE = (XIVEC(KIX) - XIVEC(KIX-1))/(VVEC(KIX) - VVEC(KIX-1))	05	00710
	PZCU = VVEC(KIX) - XIVEC(KIX)/SLOPE	05	00720
	DELTA1 = (PZCU - PZCD) - DELTA1	05	00730
	DO 2704 I = 2,101	05	00740
2704	VVEC(I) = VVEC(I) + DELTA1	05	00750
C	CURRENT DEGRADATION IS NOW COMPLETE	05	00760
C	GO ON TO DO SERIES RESISTANCE DEGRADATION	05	00770
C	STORE ALPH0 AND AVPM0 AND FETCH NEW BATCH OF VARIABLES	05	00780
	ALPH0=DV	05	00790
	AVPM0=DISC	05	00800
	RETURN	05	00810
C	.....	05	00820
C	IN SECOND CALL	05	00830
C	SIGISC IS DV	05	00840
C	SIGVOC IS DISC	05	00850
C	DISC IS SIGISC	05	00860
C	DV IS SIGVOC	05	00870
C	TNOT IS TNOT	05	00880
C	KEY IS 0	05	00890
C	NGRIPE IS NGRIPE	05	00900
C	NCELLT IS NCELLT	05	00910
C	VOC01 IS DENFAC	05	00920
C	ADDT IS ADPT	05	00930
C	DELTT IS DELTT	05	00940
3000	ALFA=SIGISC	05	00950
	DENFAC=VOC01	05	00960
	TKI=DISC	05	00970
	TKV=DV	05	00980
	RES=((1.0-ALFA)*AVPM0/ALPH0)	05	00990
	DO 3001 I = 1,101	05	01000
3001	VVEC(I)=VVEC(I)-XIVEC(I)*RES	05	01010
C	SERIES RESISTANCE DEGRADATION IS NOW COMPLETE	05	01020

C	DETERMINE VOC - LOCATE FIRST NEGATIVE ELEMENT IN XIVEC	05	01030
	DO 3007 I = 2,101	05	01040
	N=1	05	01050
	IF(XIVEC(I))3006,3006,3007	05	01060
3007	CONTINUE	05	01070
3006	VOC=VVEC(N-1)+XIVEC(N-1)*(VVEC(N)-VVEC(N-1))/(XIVEC(N-1)-XIVEC(N))	05	01080
C	FILL TEMPERATURE VECTOR	05	01090
	IF (DELTT) 3012,3012,3013	05	01100
3012	ADDT = 120.0	05	01110
	DELTT = 20.0	05	01120
3013	CONTINUE	05	01130
	TEMP(1) = TNOT + ADDT	05	01140
	VOCT(1)= VOC-ADDT*TKV	05	01150
	DO 3202 I=2,15	05	01160
	TEMP(I) = TEMP(I-1) - DELTT	05	01170
3202	VOCT(I)=VOC-(TEMP(I)-TNOT)*TKV	05	01180
C	EXPAND I-V CURVE INTO FAMILY OF CURVES FOR 15 TEMPERATURES	05	01190
C	OUTER DO FOR EACH TEMPERATURE ON INDEX I	05	01200
	DO 3040 I=1,15	05	01210
C	FIRST INNER DO FOR VOLTAGES ON INDEX J	05	01220
	T2T1=TEMP(I)-TNOT	05	01230
	DELTA V=TKV*T2T1	05	01240
	DO 3204 J = 1,101	05	01250
3204	VMAP(I,J)=VVEC(J)-DELTA V	05	01260
	XKIT=TKI*T2T1*SIGVOC	05	01270
	DENOM=VOC-DENFAC-TKV*T2T1	05	01280
C	SECOND INNER DO FOR CURRENTS ON INDEX J	05	01290
	DO 3205 J = 1,101	05	01300
	Z=VMAP(I,J)/DENOM	05	01310
	Z6 = Z**8	05	01320
	UMZ6=1.0-Z6	05	01330
	IF(UMZ6)3300,3205,3205	05	01340
3300	UMZ6=0.0	05	01350
3205	XIMAP(I,J)=XIVEC(J)+XKIT*UMZ6	05	01360
3040	CONTINUE	05	01370
C	FIND V AND I AT MAXIMUM POWER POINT FOR EACH TEMPERATURE	05	01380
	DO 4005 I=1,15	05	01390
	N=4	05	01400
	PWR= -1000000.0	05	01410
4000	PWRT=VMAP(I,N)*XIMAP(I,N)	05	01420
	IF(PWRT-PWR) 4002,4004,4001	05	01430
4001	N=N+1	05	01440
	PWR=PWRT	05	01450
	GO TO 4000	05	01460
4004	VMP(I)=VMAP(I,N)	05	01470
	XIMP(I)=XIMAP(I,N)	05	01480
	GO TO 4005	05	01490
4002	SLOPE=(XIMAP(I,N-1)-XIMAP(I,N))/(VMAP(I,N)-VMAP(I,N-1))	05	01500
4003	VMP(I)=VMAP(I,N-1)+0.00015	05	01510
	XIMP(I)=XIMAP(I,N-1)-SLOPE*(VMP(I)-VMAP(I,N-1))	05	01520
	PWRT=VMP(I)*XIMP(I)	05	01530
	IF (PWRT-PWR) 4005,4005,4008	05	01540
4008	PWR=PWRT	05	01550
	GO TO 4003	05	01560
4005	CONTINUE	05	01570
	DO 100 I = 1,15	05	01580
	PWRSTG(I) = VMP(I)*XIMP(I)	05	01590
100	CONTINUE	05	01600
4006	DO 4009 I = 1,15	05	01610
	DO 4010 N = 1,101	05	01620
	IF (VMAP (I,N))4010,4007,4007	05	01630
4007	XISCT(I) = XIMAP(I,N)	05	01640
	GO TO 4009	05	01650
4010	CONTINUE	05	01660
4009	CONTINUE	05	01670
C	EDIT RESULTS	05	01680



WRITE (IB,7000)	05 01690
WRITE (IB,7001)(TEMP(J),J=1,15)	05 01700
WRITE (IB,7002)(XIMP(J),J=1,15)	05 01710
WRITE (IB,7003)(VMP(J),J=1,15)	05 01720
WRITE (IB,7006)(VOCT(I),I=1,15)	05 01730
WRITE (IB,7007)(XISCT(I),I=1,15)	05 01740
WRITE (IB,7008)(PWRSTG(I),I=1,15)	05 01750
DO 2040 J=1,30,2	05 01760
2040 WRITE (IB,7004)J,(XIMAP(I,J),I=1,15)	05 01770
WRITE (IB,7005)J,(VMAP(I,J),I=1,15)	05 01780
WRITE (IB,7000)	05 01790
WRITE (IB,7001)(TEMP(J),J=1,15)	05 01800
WRITE (IB,7002)(XIMP(J),J=1,15)	05 01810
WRITE (IB,7003)(VMP(J),J=1,15)	05 01820
WRITE (IB,7006)(VOCT(I),I=1,15)	05 01830
WRITE (IB,7007)(XISCT(I),I=1,15)	05 01840
WRITE (IB,7008)(PWRSTG(I),I=1,15)	05 01850
DO 2041 J = 31,60,2	05 01860
2041 WRITE (IB,7004)J,(XIMAP(I,J),I=1,15)	05 01870
WRITE (IB,7005)J,(VMAP(I,J),I=1,15)	05 01880
WRITE (IB,7000)	05 01890
WRITE (IB,7001)(TEMP(J),J=1,15)	05 01900
WRITE (IB,7002)(XIMP(J),J=1,15)	05 01910
WRITE (IB,7003)(VMP(J),J=1,15)	05 01920
WRITE (IB,7006)(VOCT(I),I=1,15)	05 01930
WRITE (IB,7007)(XISCT(I),I=1,15)	05 01940
WRITE (IB,7008)(PWRSTG(I),I=1,15)	05 01950
DO 2042 J = 61,90,2	05 01960
2042 WRITE (IB,7004)J,(XIMAP(I,J),I=1,15)	05 01970
WRITE (IB,7005)J,(VMAP(I,J),I=1,15)	05 01980
WRITE (IB,7000)	05 01990
WRITE (IB,7001)(TEMP(J),J=1,15)	05 02000
WRITE (IB,7002)(XIMP(J),J=1,15)	05 02010
WRITE (IB,7003)(VMP(J),J=1,15)	05 02020
WRITE (IB,7006)(VOCT(I),I=1,15)	05 02030
WRITE (IB,7007)(XISCT(I),I=1,15)	05 02040
WRITE (IB,7008)(PWRSTG(I),I=1,15)	05 02050
DO 2043 J = 91,99,2	05 02060
2043 WRITE (IB,7004)J,(XIMAP(I,J),I=1,15)	05 02070
WRITE (IB,7005)J,(VMAP(I,J),I=1,15)	05 02080
RETURN	05 02090
C EDIT FORMATS	05 02100
7000 FORMAT (10H1 EDIT OF TEMPERATURE AND DEGRADATION CORRECTED SOLAR	05 02110
1 CELL I-V CURVES FOR SOLAR ARRAY SYNTHESIS PROGRAM)	05 02120
7001 FORMAT (14H0 TEMPERATURES15F7.0)	05 02130
7002 FORMAT (14H0 I-MAX PWR 15F7.4)	05 02140
7003 FORMAT (14H0 V-MAX PWR 15F7.4)	05 02150
7004 FORMAT (4H0 I(12,8H) 15F7.4)	05 02160
7005 FORMAT (4H0 V(12,8H) 15F7.4)	05 02170
7006 FORMAT (14H0 VOLTS OC 15F7.4)	05 02180
7007 FORMAT (14H0 AMPS SC 15F7.4)	05 02190
7008 FORMAT (14H0 MAX POWER 15F7.4)	05 02200
C LOOK UP CURRENT AND MAX PWR POINT GIVEN VCELL + TEMPERATURE	05 02210
1000 VCELL=DISC	05 02220
HELHOT=DV	05 02230
NK = (TEMP(1) - HELHOT)/DELTT	05 02240
NHI=NK+1	05 02250
NLO=NK+2	05 02260
IF (KEY = 989) 1334,1333,1334	05 02270
C FOR KEY = 989 INTO SIGISC PUT OPEN CIRCUIT VOLTAGE AT TEMPERATURE	05 02280
1333 SIGISC = VOCT(NLO)+(DV-TEMP(NLO))/DELTT*(VOCT(NHI)-VOCT(NLO))	05 02290
RETURN	05 02300
1334 IF (KEY = 988) 1335,1336,1335	05 02310
C FOR KEY = 988 INTO SIGISC PUT VOLTAGE AT THE GIVEN CURRENT	05 02320
1336 DO 1402 J = 2,101	05 02330
N = J	05 02340

IF (VCELL- XIMAP(NLO,J))1402,1402,1403	05 02350
1402 CONTINUE	05 02360
1403 XILO = VMAP(NLO,N-1) + (VCELL - XIMAP(NLO,N-1))* (VMAP(NLO,N) -	05 02370
1VMAP(NLO,N-1))/(XIMAP(NLO,N)-XIMAP(NLO,N-1))	05 02380
DO 1422 J = 2,101	05 02390
N = J	05 02400
IF (VCELL- XIMAP(NHI,J))1422,1422,1423	05 02410
1422 CONTINUE	05 02420
1423 CONTINUE	05 02430
XIHI = VMAP(NHI,N-1) + (VCELL - XIMAP(NHI,N-1))* (VMAP(NHI,N) -	05 02440
1VMAP(NHI,N-1))/(XIMAP(NHI,N) - XIMAP(NHI,N-1))	05 02450
GO TO 1210	05 02460
1335 CONTINUE	05 02470
IF(VCELL-VMAP(NLO,1))1100,1100,1001	05 02480
1100 XILO=XIMAP(NLO,1)	05 02490
GO TO 1010	05 02500
1001 DO 1002 J = 2,101	05 02510
N=J	05 02520
IF(VCELL-VMAP(NLO,J))1003,1003,1002	05 02530
1002 CONTINUE	05 02540
1003 XILO=XIMAP(NLO,N-1)+(VCELL-VMAP(NLO,N-1))*(XIMAP(NLO,N)-XIMAP(NLO,	05 02550
1N-1))/(VMAP(NLO,N)-VMAP(NLO,N-1))	05 02560
1010 IF(VCELL-VMAP(NHI,1))1200,1200,1020	05 02570
1200 XIHI=XIMAP(NHI,1)	05 02580
GO TO 1210	05 02590
1020 DO 1222 J = 2,101	05 02600
N=J	05 02610
IF(VCELL-VMAP(NHI,J))1023,1023,1222	05 02620
1222 CONTINUE	05 02630
1023 XIHI=XIMAP(NHI,N-1)+(VCELL-VMAP(NHI,N-1))*(XIMAP(NHI,N)-XIMAP(NHI,	05 02640
1N-1))/(VMAP(NHI,N)-VMAP(NHI,N-1))	05 02650
1210 FAKTOR=(HELHOT-TEMP(NLO))/(TEMP(NHI)-TEMP(NLO))	05 02660
C XICELL PUT INTO SIGISC	05 02670
SIGISC=XILO+(XIHI-XILO)*FAKTOR	05 02680
RETURN	05 02690
END	05 02700

# Appendix B

071768 0

## SAMPLE TABLES

08-13-6800012701	11.4	CRL	BARE	CELL	1	OHM-CM	%NIMBUS	DC	00
0.0	0.25	0.30	0.35	0.37	0.39	0.40	0.41	0.42	01
0.1420	0.1420	0.1412	0.1412	0.1409	0.1400	0.1397	0.1390	0.1380	02
0.43	0.44	0.45	0.46	0.47	0.48	0.49	0.50	0.51	03
0.1369	0.1355	0.1332	0.1312	0.1289	0.1256	0.1210	0.1161	0.1088	04
0.52	0.53	0.54	0.55	0.56	0.57	0.590	0.600	1.0	05
0.1005	0.0925	0.0825	0.0700	0.0550	0.0388	0.0	-0.0125	-0.012506	06
05-13-6800023601	RELATIVE	ISC	VS	INCIDENCE	ANGLE	%KELLY	COSINE	<	00
0.0	5.0	10.0	15.0	20.0	25.0	30.0	35.0	40.0	01
1.0	0.99	0.98	0.965	0.94	0.905	0.86	0.81	0.75	02
45.0	50.0	60.0	65.0	70.0	75.0	80.0	85.0	90.0	03
0.69	0.63	0.48	0.385	0.30	0.20	0.12	0.04	0.0	04
270.0	275.0	280.0	285.0	290.0	295.0	300.0	310.0	315.0	05
0.0	0.04	0.12	0.20	0.30	0.385	0.48	0.63	0.69	06
320.0	325.0	330.0	335.0	340.0	345.0	350.0	355.0	360.0	07
0.75	0.81	0.86	0.905	0.94	0.965	0.98	0.99	1.0	08
07-30-6800031101	NIMBUS	ORBITAL	ELECTRONS	1	YR	600NM-1970			00
1.0	2.0	3.0	4.0	5.0	6.0	7.0	8.0	9.0	01
2.92	121.10	125.48	117.3	1037.2	107.81	101.61	105.40	191.72	02
10.0	11.0								03
5.91	180.0								04
07-30-6800041801	NIMBUS	ORBITAL	PROTONS	1	YR	600NM-1970			00
1.0	2.0	3.0	4.0	5.0	6.0	7.0	8.0	9.0	01
2.19	102.19	101.46	101.82	101.28	101.1	101.1	109.12	197.3	02
10.0	11.0	12.0	13.0	14.0	15.0	16.0	17.0	18.0	03
5.48	195.48	194.74	193.28	192.56	191.82	191.28	196.94	190.0	04
05-13-6800051801	NIMBUS	SOLAR	FLARE	PROTONS	1YR	600NM			00
1.0	2.0	3.0	4.0	5.0	6.0	7.0	8.0	9.0	01
0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	02
10.0	11.0	12.0	13.0	14.0	15.0	16.0	17.0	18.0	03
0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	04
05-13-6800061801	NIMBUS	SOLAR	FLARE	ALPHA	PARTICLES	1YR	600NM		00
1.0	2.0	3.0	4.0	5.0	6.0	7.0	8.0	9.0	01
0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	02
10.0	11.0	12.0	13.0	14.0	15.0	16.0	17.0	18.0	03
0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	04
09-20-6800071107	DAMAGE	FACTORS	FOR	ELECTRONS					00
1.0	2.0	3.0	4.0	5.0	6.0	7.0	8.0	9.0	01
0.0	0.01	0.06	0.18	0.38	1.3	2.9	4.35	5.5	02
1.0	0.0	0.03	0.13	0.3	1.15	2.7	4.15	5.3	03
1.5	0.0	0.02	0.08	0.2	1.02	2.5	3.92	5.15	04
3.0	0.0	0.0	0.03	0.1	0.75	2.05	3.38	4.6	05
6.0	0.0	0.0	0.0	0.02	0.47	1.55	2.85	4.1	06
9.0	0.0	0.0	0.0	0.0	0.25	1.1	2.15	3.3	07
200.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	08
10.0	11.0								09
0.0	7.4	7.8							10
1.0	7.3	7.8							11
1.5	7.3	7.8							12
3.0	6.8	7.7							13
6.0	6.5	7.5							14
9.0	5.85	7.0							15
200.0	0.0	0.0							16
09-20-6800081808	DAMAGE	FACTORS	FOR	PROTONS					00
1.0	2.0	3.0	4.0	5.0	6.0	7.0	8.0	9.0	01
0.0	20000.0	10000.0	07000.0	5400.0	4500.0	3900.0	3500.0	3100.0	02
0.5	0.0	0.0	6000.0	5400.0	4500.0	3900.0	3500.0	3100.0	03
1.0	0.0	0.0	0.0	0.0	3000.0	3700.0	3500.0	3100.0	04
1.5	0.0	0.0	0.0	0.0	0.0	2000.0	3100.0	3100.0	05
3.0	0.0	0.0	0.0	0.0	0.0	0.0	200.0	1400.0	06
6.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	07
9.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	08
200.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	09
10.0	11.0	12.0	13.0	14.0	15.0	16.0	17.0	18.0	10
0.0	2700.0	2600.0	2500.0	2500.0	2500.0	2500.0	2500.0	2300.0	11



0.5	2700.0	2600.0	2500.0	2500.0	2500.0	2500.0	2500.0	2300.0	1000.0	12
1.0	2700.0	2600.0	2500.0	2500.0	2500.0	2500.0	2500.0	2300.0	1000.0	13
1.5	2700.0	2600.0	2500.0	2500.0	2500.0	2500.0	2500.0	2300.0	1000.0	14
3.0	2000.0	2100.0	2100.0	2100.0	2000.0	2000.0	2000.0	2000.0	1000.0	15
6.0	0.0	0.0	100.0	1000.0	1400.0	1500.0	1800.0	2000.0	1000.0	16
9.0	0.0	0.0	0.0	0.0	0.0	170.0	1500.0	2000.0	1000.0	17
200.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	18
09-23-6800091807 DAMAGE FACTORS FOR ALPHA PARTICLES										00
1.0	2.0	3.0	4.0	5.0	6.0	7.0	8.0	9.0		01
0.0	20000.0	15000.0	14500.0	13700.0	12500.0	11500.0	11000.0	10400.0	09800.0	02
1.0	10000.0	13000.0	14000.0	13700.0	12500.0	11500.0	11000.0	10400.0	09800.0	03
1.5	0.0	0.0	7000.0	11000.0	12000.0	11500.0	11000.0	10400.0	09800.0	04
3.0	0.0	0.0	0.0	0.0	0.0	2500.0	5200.0	7200.0	7900.0	05
6.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	06
9.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	07
200.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	08
10.0	11.0	12.0	13.0	14.0	15.0	16.0	17.0	18.0		09
0.0	9500.0	9500.0	9500.0	9500.0	9400.0	9200.0	8600.0	7000.0	4000.0	10
1.0	9500.0	9500.0	9500.0	9500.0	9400.0	9200.0	8600.0	7000.0	4000.0	11
1.5	9500.0	9500.0	9500.0	9500.0	9400.0	9200.0	8600.0	7000.0	4000.0	12
3.0	8000.0	7800.0	7700.0	7600.0	7600.0	7600.0	7700.0	7000.0	4000.0	13
6.0	1700.0	3650.0	5300.0	5700.0	6300.0	7000.0	7400.0	7000.0	4000.0	14
9.0	0.0	0.0	0.0	1600.0	4000.0	6400.0	7100.0	7000.0	4000.0	15
200.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	0.0	16
09-20-6600102302 NMVTBL CURVE SHAPE VOLTS VS PHI										00
0.0	1.0	132.5	136.0	131.0	142.0	143.0	144.0	145.0	1401	
1.0	0.0	0.0	0.001	0.0032	0.005	0.0081	0.0103	0.012	0.0134	02
10.0	0.0	0.0	0.0	0.0012	0.0024	0.004	0.0051	0.0058	0.0064	03
6.0	148.0	141.0	151.5	152.0	152.5	153.0	153.5	154.0	1504	
1.0	0.0145	0.0163	0.0177	0.0201	0.0219	0.0232	0.0244	0.0253	0.0261	05
10.0	0.0068	0.0077	0.0085	0.0104	0.0118	0.0130	0.014	0.0149	0.0156	06
5.0	156.0	158.0	151.0	161.0	17					07
1.0	0.0275	0.0286	0.0304	0.0317	0.0457					08
10.0	0.0168	0.0179	0.0195	0.0207	0.0329					09
07-17-6800110201 ZERO INCIDENCE ANGLE										00
0.0	120.0									01
0.0	0.0									02
07-17-6800121601 NIMBUS SOLAR ARRAY TEMP VS TIME PROFILE										00
0.0	5.0	10.0	15.0	20.0	25.0	30.0	35.0	40.0		01
-60.0	-31.0	-11.0	5.0	17.0	27.0	36.0	42.0	47.0		02
45.0	50.0	55.0	60.0	65.0	70.0	75.0				03
51.0	52.0	51.0	48.0	46.0	44.0	42.0				04
RUN NO.1 3 MONTH FLUX IS 7.9EXP13										
1	20.0									
2	5.0									
3	0.00007									
4	0.0022									
5	100.0									
6	100.0									
7	100.0									
8	95.0									
9	99.0									
10	100.0									
11	0.47									
12	0.1289									
13	0.590									
14	100.0									
15	28.0									
16	1.8									
17	10.0									
18	32.0									
19	79000000000000.0									
20	6.0									
21	15.0									
22	1.0									
23	1.0									

24 4.0  
999

2  
94.0 92.0 11.0 12.0  
92.0 18.0 11.0 12.0

RUN NO.2 6 MONTH FLUX IS 1.58EXP14

5 103.0  
6 101.0  
7 103.5  
14 101.0  
19 158000000000000.0  
24 3.0

END